## DATA SHEET

# **ELPIDΛ** MOS INTEGRATED CIRCUIT μPD45128441, 45128841, 45128163

## 128M-bit Synchronous DRAM 4-bank, LVTTL

## Description

The  $\mu$ PD45128441, 45128841, 45128163 are high-speed 134,217,728-bit synchronous dynamic random-access memories, organized as 8,388,608 × 4 × 4, 4,194,304 × 8 × 4, 2,097,152 × 16 × 4 (word × bit × bank), respectively.

The synchronous DRAMs achieved high-speed data transfer using the pipeline architecture.

All inputs and outputs are synchronized with the positive edge of the clock.

The synchronous DRAMs are compatible with Low Voltage TTL (LVTTL).

These products are packaged in 54-pin TSOP (II).

## Features

- Fully Synchronous Dynamic RAM, with all signals referenced to a positive clock edge
- Pulsed interface
- Possible to assert random column address in every cycle
- Quad internal banks controlled by BA0(A13) and BA1(A12)
- Byte control (×16) by LDQM and UDQM
- Programmable Wrap sequence (Sequential / Interleave)
- Programmable burst length (1, 2, 4, 8 and full page)
- Programmable /CAS latency (2 and 3)
- Automatic precharge and controlled precharge
- CBR (Auto) refresh and self refresh
- ×4, ×8, ×16 organization
- Single 3.3 V  $\pm$  0.3 V power supply
- LVTTL compatible inputs and outputs
- 4,096 refresh cycles / 64 ms
- Burst termination by Burst stop command and Precharge command

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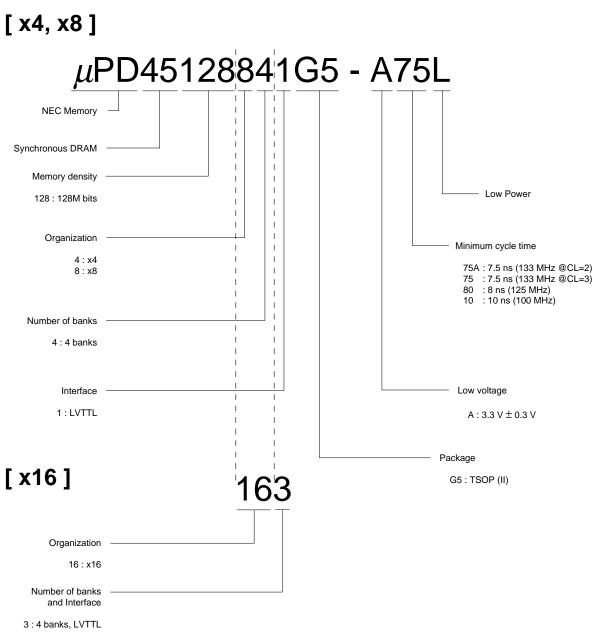
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## **Ordering Information**

| Part number            | Organization (word $\times$ bit $\times$ bank) | Clock frequency<br>MHz (MAX.) | Package                  |
|------------------------|--|-------------------------------|--------------------------|
| μPD45128441G5-A75A-9JF | $8M \times 4 \times 4$                         | 133                           | 54-pin Plastic TSOP (II) |
| μPD45128441G5-A75-9JF  |  | 133                           | (10.16mm (400))          |
| μPD45128441G5-A80-9JF  |  | 125                           |                          |
| μPD45128441G5-A10-9JF  |  | 100                           |                          |
| μPD45128841G5-A75A-9JF | $4M \times 8 \times 4$                         | 133                           |                          |
| μPD45128841G5-A75-9JF  |  | 133                           |                          |
| μPD45128841G5-A80-9JF  |  | 125                           |                          |
| μPD45128841G5-A10-9JF  |  | 100                           |                          |
| μPD45128163G5-A75A-9JF | $2M\times 16\times 4$                          | 133                           |                          |
| μPD45128163G5-A75-9JF  |  | 133                           |                          |
| μPD45128163G5-A80-9JF  |  | 125                           |                          |
| μPD45128163G5-A10-9JF  |  | 100                           |                          |
| μPD45128441G5-A75L-9JF | $8M \times 4 \times 4$                         | 133                           |                          |
| μPD45128441G5-A80L-9JF | ]  | 125                           |                          |
| μPD45128841G5-A75L-9JF | $4M \times 8 \times 4$                         | 133                           |                          |
| μPD45128841G5-A80L-9JF |  | 125                           |                          |
| μPD45128163G5-A75L-9JF | $2M\times 16\times 4$                          | 133                           |                          |
| μPD45128163G5-A80L-9JF |  | 125                           |                          |

Part Number



## **Pin Configurations**

/xxx indicates active low signal.

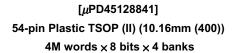
| Vcc O      | 1  | 54   |         |
|------------|----|------|---------|
| NC 0       | 2  | 53   | O NC    |
| VccQ O     | 3  | 52   |         |
| NC 0       | 4  | 51   | O NC    |
| DQ0 ○←→    | 5  | 50   | ←→O DQ3 |
| VssQ O     | 6  | 49   | O VccQ  |
| NC O       | 7  | 48   | O NC    |
| NC O       | 8  | 47   | O NC    |
| VccQ O     | 9  | 46   |         |
| NC O       | 10 | 45   | O NC    |
| DQ1 O≁→    | 11 | 44   | ←→O DQ2 |
| VssQ O     | 12 | 43   | O VccQ  |
| NC 0       | 13 | 42   | O NC    |
| Vcc O      | 14 | 41   |         |
| NC O       | 15 | 40   | O NC    |
| /WE O→     | 16 | 39 - | ←O DQM  |
| /CAS O►    | 17 | 38 - | ←—O CLK |
| /RAS O►    | 18 | 37   | ←O CKE  |
| /CS ○>     | 19 | 36 - | O NC    |
| BA0(A13) ⊖ | 20 | 35 - | ←OA11   |
| BA1(A12) ⊖ | 21 | 34   |         |
| A10 ⊖►     | 22 | 33 - | ←OA8    |
| A0         | 23 | 32   | ←OA7    |
| A1         | 24 | 31   | ⊖A6     |
| A2         | 25 | 30   | OA5     |
| A3         | 26 | 29   | ←OA4    |
| Vcc O      | 27 | 28   | ⊖Vss    |
|            |    |      |         |

| 54-pin Plastic TSOP (II) (10.16mm (400)) |             |            |                  |    |  |
|--|-------------|------------|------------------|----|--|
|  | 1           | 8M words 🗙 | 4 bits × 4 banks | 5  |  |
|  |             |            |                  |    |  |
|  |             |            | $\bigcirc$       |    |  |
| Vcc (                                    | )——         | 1          |                  | 54 | O Vs                                   |
| NC (                                     | )C          | 2          |                  | 53 | O NG                                   |
| VccQ (                                   | )——         | 3          |                  | 52 | —————————————————————————————————————— |
| NC                                       | )C          | 4          |                  | 51 | O NG                                   |
| DQ0                                      | )≁→         | 5          |                  | 50 |  |
| VssQ (                                   | )——         | 6          |                  | 49 | —————————————————————————————————————— |
| NC (                                     | <b>)</b> —— | 7          |                  | 48 | O N(                                   |
| NC (                                     | <u> </u>    | 8          |                  | 47 | O N(                                   |

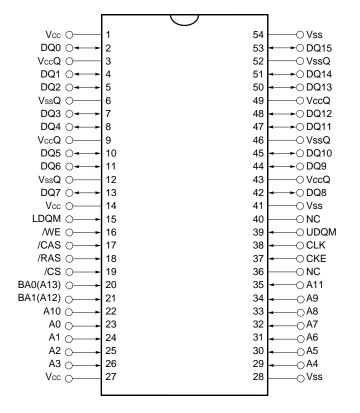
[µPD45128441]

| A0 to A11 Note   | : Address inputs        |      |              |                          |
|------------------|-------------------------|------|--------------|--------------------------|
| BA0(A13), BA1(A1 | 2): Bank select         |      |              |                          |
| DQ0 to DQ3       | : Data inputs / outputs |      |              |                          |
| CLK              | : Clock input           |      |              |                          |
| CKE              | : Clock enable          |      |              |                          |
| /CS              | : Chip select           |      |              |                          |
| /RAS             | : Row address strobe    |      |              |                          |
| /CAS             | : Column address strobe |      |              |                          |
| /WE              | : Write enable          |      |              |                          |
| DQM              | : DQ mask enable        |      |              |                          |
| Vcc              | : Supply voltage        |      |              |                          |
| Vss              | : Ground                |      |              |                          |
| VccQ             | : Supply voltage for DQ | Note | A0 to A11    | : Row address inputs     |
| VssQ             | : Ground for DQ         |      | A0 to A9, A1 | I: Column address inputs |
| NC               | : No connection         |      |              |                          |

|                         | $\bigcirc$ |      |                                       |
|-------------------------|------------|------|---------------------------------------|
| Vcc O                   | 1          | 54   |                                       |
| DQ0 O <del>&lt; →</del> | 2          | 53   | ←→O DQ7                               |
| VccQ O                  | 3          | 52   |                                       |
| NC O                    | 4          | 51   | O NC                                  |
| DQ1 O <del>&lt;→</del>  | 5          | 50   | ← → O DQ6                             |
| VssQ O                  | 6          | 49   |                                       |
| NC O                    | 7          | 48   | O NC                                  |
| DQ2 O                   | 8          | 47   | ←→O DQ5                               |
| VccQ O                  | 9          | 46   |                                       |
| NC O                    | 10         | 45   | O NC                                  |
| DQ3 O                   | 11         | 44   | ←→O DQ4                               |
| VssQ O                  | 12         | 43   |                                       |
| NC O                    | 13         | 42   | O NC                                  |
| Vcc O                   | 14         | 41   |                                       |
| NC O                    | 15         | 40   | O NC                                  |
| /WE ○►                  | 16         | 39 - | ←─── DQM                              |
| /CAS ○>                 | 17         | 38 - | ←———————————————————————————————————— |
| /RAS O►                 | 18         | 37 - | ←———————————————————————————————————— |
| /CS ○►                  | 19         | 36   | O NC                                  |
| BA0(A13) O              | 20         | 35 - | ←O A11                                |
| BA1(A12) ⊖►             | 21         | 34 - | ←OA9                                  |
| A10 O►                  | 22         | 33 - | ⊷OA8                                  |
| A0 ⊖                    | 23         | 32   | ←OA7                                  |
| A1 ⊖►                   | 24         | 31 - | ⊖A6                                   |
| A2 ⊖►                   | 25         | 30 - | <b>↓</b> OA5                          |
| A3 ⊖►                   | 26         | 29 - | ⊖A4                                   |
| Vcc O                   | 27         | 28 - | OVss                                  |
|                         |            |      |                                       |



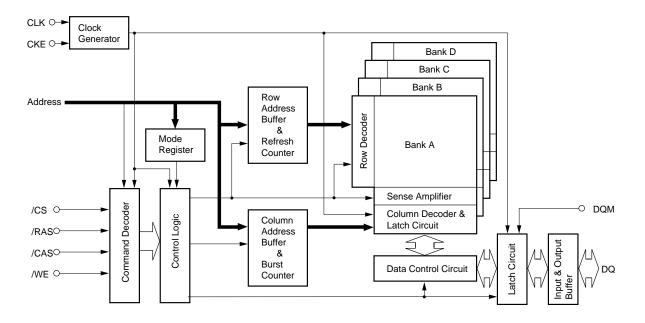
| A0 to A11 <sup>Note</sup> | : Address inputs        |      |                                  |
|---------------------------|-------------------------|------|----------------------------------|
| BA0(A13), BA1(A12         | 2): Bank select         |      |                                  |
| DQ0 to DQ7                | : Data inputs / outputs |      |                                  |
| CLK                       | : Clock input           |      |                                  |
| CKE                       | : Clock enable          |      |                                  |
| /CS                       | : Chip select           |      |                                  |
| /RAS                      | : Row address strobe    |      |                                  |
| /CAS                      | : Column address strobe |      |                                  |
| /WE                       | : Write enable          |      |                                  |
| DQM                       | : DQ mask enable        |      |                                  |
| Vcc                       | : Supply voltage        |      |                                  |
| Vss                       | : Ground                | Note | A0 to A11 : Row address inputs   |
| VccQ                      | : Supply voltage for DQ |      | A0 to A9 : Column address inputs |
| VssQ                      | : Ground for DQ         |      |                                  |
| NC                        | : No connection         |      |                                  |



| [ <i>μ</i> PD45128163]                   |
|--|
| 54-pin Plastic TSOP (II) (10.16mm (400)) |
| 2M words × 16 bits × 4 banks             |

| A0 to A11 Note : Address inputs     |                                  |
|-------------------------------------|----------------------------------|
| BA0(A13), BA1(A12): Bank select     |                                  |
| DQ0 to DQ15 : Data inputs / outputs |                                  |
| CLK : Clock input                   |                                  |
| CKE : Clock enable                  |                                  |
| /CS : Chip select                   |                                  |
| /RAS : Row address strobe           |                                  |
| /CAS : Column address strobe        |                                  |
| /WE : Write enable                  |                                  |
| LDQM : Lower DQ mask enable         |                                  |
| UDQM : Upper DQ mask enable         |                                  |
| Vcc : Supply voltage                |                                  |
| Vss : Ground Note A                 | A0 to A11 : Row address inputs   |
| VccQ : Supply voltage for DQ A      | A0 to A8 : Column address inputs |
| VssQ : Ground for DQ                |                                  |
| NC : No connection                  |                                  |

## **Block Diagram**



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## 1. Input / Output Pin Function

| Pin name             | Input / Output | Function   |
|----------------------|----------------|--|
| CLK                  | Input          | CLK is the master clock input. Other inputs signals are referenced to the CLK rising edge.   |
| CKE                  | Input          | CKE determine validity of the next CLK (clock). If CKE is high, the next CLK rising edge is valid; otherwise it is invalid. If the CLK rising edge is invalid, the internal clock is not issued and the $\mu$ PD45128xxx suspends operation.<br>When the $\mu$ PD45128xxx is not in burst mode and CKE is negated, the device enters power down mode. During power down mode, CKE must remain low.   |
| /CS                  | Input          | /CS low starts the command input cycle. When /CS is high, commands are ignored but operations continue.  |
| /RAS, /CAS, /WE      | Input          | /RAS, /CAS and /WE have the same symbols on conventional DRAM but different functions. For details, refer to the command table.  |
| A0 - A11             | Input          | Row Address is determined by A0 - A11 at the CLK (clock) rising edge in the active command cycle. It does not depend on the bit organization.<br>Column Address is determined by A0 - A9, A11 at the CLK rising edge in the read or write command cycle. It depends on the bit organization: A0 - A9, A11 for ×4 device, A0 - A9 for ×8 device, A0 - A8 for ×16 device.<br>A10 defines the precharge mode. When A10 is high in the precharge command cycle, all banks are precharged; when A10 is low, only the bank selected by BA0(A13) and BA1(A12) is precharged.<br>When A10 is high in read or write command cycle, the precharge starts automatically after the burst access. |
| BA0, BA1             | Input          | BA0(A13) and BA1(A12) are the bank select signal. In command cycle, BA0(A13) and BA1(A12) low select bank A, BA0(A13) high and BA1(A12) low select bank B, BA0(A13) low and BA1(A12) high select bank C and then BA0(A13) and BA1(A12) high select bank D.   |
| DQM, UDQM, LDQM      | Input          | DQM controls I/O buffers. In ×16 products, UDQM and LDQM control upper byte and<br>lower byte I/O buffers, respectively.<br>In read mode, DQM controls the output buffers like a conventional /OE pin.<br>DQM high and DQM low turn the output buffers off and on, respectively.<br>The DQM latency for the read is two clocks.<br>In write mode, DQM controls the word mask. Input data is written to the memory cell if<br>DQM is low but not if DQM is high.<br>The DQM latency for the write is zero.  |
| DQ0 - DQ15           | Input / Output | DQ pins have the same function as I/O pins on a conventional DRAM.   |
| Vcc, Vss, VccQ, VssQ | (Power supply) | Vcc and Vss are power supply pins for internal circuits. VccQ and VssQ are power supply pins for the output buffers.   |

## 2. Commands

## Mode register set command

(/CS, /RAS, /CAS, /WE = Low)

The  $\mu$ PD45128xxx has a mode register that defines how the device operates. In this command, A0 through A11, BA0(A13) and BA1(A12) are the data input pins. After power on, the mode register set command must be executed to initialize the device.

The mode register can be set only when all banks are in idle state. During 2 CLK (trsc) following this command, the  $\mu$ PD45128xxx cannot accept any other commands.

#### Activate command

(/CS, /RAS = Low, /CAS, /WE = High)

The  $\mu$ PD45128xxx has four banks, each with 4,096 rows. This command activates the bank selected by BA0(A13) and BA1(A12) and a row address selected by A0 through A11. This command corresponds to a conventional DRAM's /RAS falling.

#### Precharge command

(/CS, /RAS, /WE = Low, /CAS = High)

This command begins precharge operation of the bank selected by BA0(A13) and BA1(A12). When A10 is High, all banks are precharged, regardless of BA0(A13) and BA1(A12). When A10 is Low, only the bank selected by BA0(A13) and BA1(A12) is precharged.

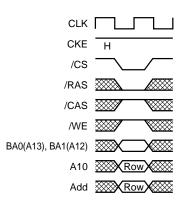
After this command, the  $\mu$ PD45128xxx can't accept the activate command to the precharging bank during t<sub>RP</sub> (precharge to activate command period).

This command corresponds to a conventional DRAM's /RAS rising.

#### Fig.1 Mode register set command

| CLK                |          |
|--------------------|----------|
| CKE                | Н        |
| /CS                | $\frown$ |
| /RAS               |          |
| /CAS               |          |
| /WE                |          |
| BA0(A13), BA1(A12) |          |
| A10                |          |
| Add                |          |

Fig.2 Row address strobe and bank activate command



#### Fig.3 Precharge command

| CLK                       |          |
|---------------------------|----------|
| CKE                       | Н        |
| /CS                       | $\frown$ |
| /RAS                      |          |
| /CAS                      | ×        |
| /WE                       |          |
| BA0(A13), BA1(A12)        |          |
| A10<br>(Precharge select) |          |
| Add                       |          |

Fig.4 Column address and write command

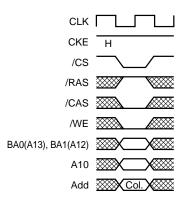
## Write command

(/CS, /CAS, /WE = Low, /RAS = High)

(/CS, /CAS = Low, /RAS, /WE = High)

If the mode register is in the burst write mode, this command sets the burst start address given by the column address to begin the burst write operation. The first write data in burst mode can input with this command with subsequent data on following clocks.

Read data is available after /CAS latency requirements have been met. This command sets the burst start address given by the column



## Read command

address.

#### Fig.5 Column address and read command

| CLK                |          |
|--------------------|----------|
| CKE                | Н        |
| /CS                | $\frown$ |
| /RAS               |          |
| /CAS               |          |
| /WE                |          |
| BA0(A13), BA1(A12) |          |
| A10                |          |
| Add                | Col.     |

#### CBR (auto) refresh command

## Fig.6 CBR (auto) refresh command

| CLK                |          |
|--------------------|----------|
| CKE                | Н        |
| /CS                | $\frown$ |
| /RAS               |          |
| /CAS               |          |
| /WE                |          |
| BA0(A13), BA1(A12) |          |
| A10                |          |
| Add                |          |

This command is a request to begin the CBR (auto) refresh operation. The refresh address is generated internally.

Before executing CBR (auto) refresh, all banks must be precharged. After this cycle, all banks will be in the idle (precharged) state and ready for a row activate command.

During tRc period (from refresh command to refresh or activate command), the  $\mu$ PD45128xxx cannot accept any other command.

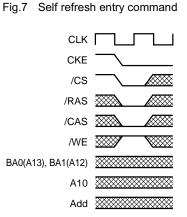
## Self refresh entry command

(/CS, /RAS, /CAS, CKE = Low, /WE = High)

After the command execution, self refresh operation continues while CKE remains low. When CKE goes high, the  $\mu$ PD45128xxx exits the self refresh mode.

During self refresh mode, refresh interval and refresh operation are performed internally, so there is no need for external control.

Before executing self refresh, all banks must be precharged.



| Burst stop command                  |  |
|-------------------------------------|--|
| (/CS, /WE = Low, /RAS, /CAS = High) |  |

This command can stop the current burst operation.

| Мо   | de |
|------|----|
| CLK  |    |
| CKE  | Н  |
| /CS  |    |
| /RAS |    |
| /CAS |    |

/WE 🔆 BA0(A13), BA1(A12)

> A10

Fig.8 Burst stop command in Full Page

No operation

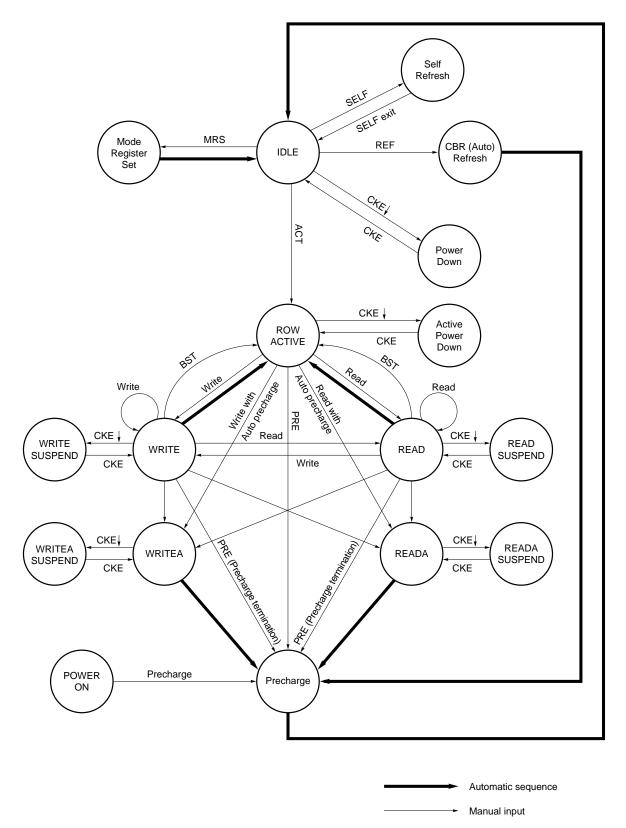
(/CS = Low, /RAS, /CAS, /WE = High)

This command is not an execution command. No operations begin or terminate by this command.

# Fig.9 No operation

| CLK                |   |
|--------------------|---|
| CKE                | Н |
| /CS                |   |
| /RAS               |   |
| /CAS               |   |
| /WE                |   |
| BA0(A13), BA1(A12) |   |
| A10                |   |
| Add                |   |

3. Simplified State Diagram



## 4. Truth Table

## 4.1 Command Truth Table

| Function                  | Symbol | CI    | CKE |   | /RAS | /CAS | /WE | BA1, | A10 | A11,    |
|---------------------------|--------|-------|-----|---|------|------|-----|------|-----|---------|
|                           |        | n – 1 | n   |   |      |      |     | BA0  |     | A9 - A0 |
| Device deselect           | DESL   | Н     | ×   | Н | ×    | ×    | ×   | ×    | ×   | ×       |
| No operation              | NOP    | Н     | ×   | L | Н    | Н    | Н   | ×    | ×   | ×       |
| Burst stop                | BST    | Н     | ×   | L | Н    | Н    | L   | ×    | ×   | ×       |
| Read                      | READ   | Н     | ×   | L | Н    | L    | н   | V    | L   | V       |
| Read with auto precharge  | READA  | Н     | ×   | L | Н    | L    | Н   | V    | Н   | V       |
| Write                     | WRIT   | Н     | ×   | L | Н    | L    | L   | V    | L   | V       |
| Write with auto precharge | WRITA  | Н     | ×   | L | Н    | L    | L   | V    | Н   | V       |
| Bank activate             | ACT    | Н     | ×   | L | L    | Н    | Н   | V    | V   | V       |
| Precharge select bank     | PRE    | Н     | ×   | L | L    | Н    | L   | V    | L   | ×       |
| Precharge all banks       | PALL   | Н     | ×   | L | L    | Н    | L   | ×    | Н   | ×       |
| Mode register set         | MRS    | Н     | ×   | L | L    | L    | L   | L    | L   | V       |

Remark H = High level, L = Low level, × = High or Low level (Don't care), V = Valid data input

## 4.2 DQM Truth Table

| Function                                  | Symbol | CI    | <Ε | DC | QM |  |
|---|--------|-------|----|----|----|--|
|   |        | n – 1 | n  | U  | L  |  |
| Data write / output enable                | ENB    | Н     | ×  | l  | -  |  |
| Data mask / output disable                | MASK   | Н     | ×  | н  |    |  |
| Upper byte write enable / output enable   | ENBU   | Н     | ×  | L  | ×  |  |
| Lower byte write enable / output enable   | ENBL   | Н     | ×  | ×  | L  |  |
| Upper byte write inhibit / output disable | MASKU  | Н     | ×  | н  | ×  |  |
| Lower byte write inhibit / output disable | MASKL  | Н     | ×  | ×  | Н  |  |

**Remark** H = High level, L = Low level, × = High or Low level (Don't care)

## 4.3 CKE Truth Table

| Current state | Function                   | Symbol | CI    | CKE |   | /RAS | /CAS | /WE | Address |
|---------------|----------------------------|--------|-------|-----|---|------|------|-----|---------|
|               |                            |        | n – 1 | n   |   |      |      |     |         |
| Activating    | Clock suspend mode entry   |        | Н     | L   | × | ×    | ×    | ×   | ×       |
| Any           | Clock suspend mode         |        | L     | L   | × | ×    | ×    | ×   | ×       |
| Clock suspend | Clock suspend mode exit    |        | L     | Н   | × | ×    | ×    | ×   | ×       |
| Idle          | CBR (auto) refresh command | REF    | Н     | Н   | L | L    | L    | н   | ×       |
| Idle          | Self refresh entry         | SELF   | Н     | L   | L | L    | L    | н   | ×       |
| Self refresh  | Self refresh exit          |        | L     | Н   | L | Н    | Н    | н   | ×       |
|               |                            |        | L     | Н   | Н | ×    | ×    | ×   | ×       |
| Idle          | Power down entry           |        | Н     | L   | × | ×    | ×    | ×   | ×       |
| Power down    | Power down exit            |        | L     | Н   | Н | ×    | ×    | ×   | ×       |
|               |                            |        | L     | Н   | L | Н    | Н    | Н   | ×       |

**Remark** H = High level, L = Low level, × = High or Low level (Don't care)

## 4.4 Operative Command Table Note1

(1/3)

| Current state | /CS | /RAS | /CAS | /WE | Address     | Command    | Action   | Notes |
|---------------|-----|------|------|-----|-------------|------------|--|-------|
| Idle          | Н   | ×    | ×    | ×   | ×           | DESL       | Nop or power down                                    | 2     |
|               | L   | н    | н    | ×   | ×           | NOP or BST | Nop or power down                                    | 2     |
|               | L   | Н    | L    | Н   | BA, CA, A10 | READ/READA | ILLEGAL  | 3     |
|               | L   | Н    | L    | L   | BA, CA, A10 | WRIT/WRITA | ILLEGAL  | 3     |
|               | L   | L    | н    | н   | BA, RA      | ACT        | Row activating                                       |       |
|               | L   | L    | Н    | L   | BA, A10     | PRE/PALL   | Nop  |       |
|               | L   | L    | L    | Н   | ×           | REF/SELF   | CBR (auto) refresh or self refresh                   | 4     |
|               | L   | L    | L    | L   | Op-Code     | MRS        | Mode register accessing                              |       |
| Row active    | Н   | ×    | ×    | ×   | ×           | DESL       | Nop  |       |
|               | L   | н    | н    | ×   | ×           | NOP or BST | Nop  |       |
|               | L   | Н    | L    | Н   | BA, CA, A10 | READ/READA | Begin read : Determine AP                            | 5     |
|               | L   | н    | L    | L   | BA, CA, A10 | WRIT/WRITA | Begin write : Determine AP                           | 5     |
|               | L   | L    | Н    | Н   | BA, RA      | ACT        | ILLEGAL  | 3     |
|               | L   | L    | н    | L   | BA, A10     | PRE/PALL   | Precharge  | 6     |
|               | L   | L    | L    | н   | ×           | REF/SELF   | ILLEGAL  |       |
|               | L   | L    | L    | L   | Op-Code     | MRS        | ILLEGAL  |       |
| Read          | н   | ×    | ×    | ×   | ×           | DESL       | Continue burst to end $\rightarrow$ Row active       |       |
|               | L   | н    | н    | н   | ×           | NOP        | Continue burst to end $\rightarrow$ Row active       |       |
|               | L   | н    | н    | L   | ×           | BST        | Burst stop $\rightarrow$ Row active                  |       |
|               | L   | н    | L    | н   | BA, CA, A10 | READ/READA | Terminate burst, new read : Determine AP             | 7     |
|               | L   | Н    | L    | L   | BA, CA, A10 | WRIT/WRITA | Terminate burst, start write : Determine AP          | 7, 8  |
|               | L   | L    | н    | н   | BA, RA      | ACT        | ILLEGAL  | 3     |
|               | L   | L    | Н    | L   | BA, A10     | PRE/PALL   | Terminate burst, precharging                         |       |
|               | L   | L    | L    | н   | ×           | REF/SELF   | ILLEGAL  |       |
|               | L   | L    | L    | L   | Op-Code     | MRS        | ILLEGAL  |       |
| Write         | Н   | ×    | ×    | ×   | ×           | DESL       | Continue burst to end $\rightarrow$ Write recovering |       |
|               | L   | н    | н    | н   | ×           | NOP        | Continue burst to end $\rightarrow$ Write recovering |       |
|               | L   | н    | н    | L   | ×           | BST        | Burst stop $\rightarrow$ Row active                  |       |
|               | L   | н    | L    | н   | BA, CA, A10 | READ/READA | Terminate burst, start read : Determine AP           | 7, 8  |
|               | L   | н    | L    | L   | BA, CA, A10 | WRIT/WRITA | Terminate burst, new write : Determine AP            | 7     |
|               | L   | L    | Н    | н   | BA, RA      | ACT        | ILLEGAL  | 3     |
|               | L   | L    | н    | L   | BA, A10     | PRE/PALL   | Terminate burst, precharging                         | 9     |
|               | L   | L    | L    | н   | ×           | REF/SELF   | ILLEGAL  |       |
|               | L   | L    | L    | L   | Op-Code     | MRS        | ILLEGAL  |       |

| _                               |     |      |      |        |             |  |  | (2/3) |
|---------------------------------|-----|------|------|--------|-------------|--|--|-------|
| Current state                   | /CS | /RAS | /CAS | /WE    | Address     | Command  | Action   | Notes |
| Read with auto                  | Н   | ×    | ×    | ×      | Х           | DESL   | Continue burst to end $\rightarrow$ Precharging                          |       |
| precharge                       | L   | Н    | Н    | Н      | ×           | NOP  | Continue burst to end $\rightarrow$ Precharging                          |       |
|                                 | L   | Н    | Н    | L      | ×           | BST  | ILLEGAL  |       |
|                                 | L   | Н    | L    | Н      | BA, CA, A10 | READ/READA   | ILLEGAL  | 3     |
|                                 | L   | Н    | L    | L      | BA, CA, A10 | WRIT/WRITA   | ILLEGAL  | 3     |
|                                 | L   | L    | н    | н      | BA, RA      | ACT  | ILLEGAL  | 3     |
|                                 | L   | L    | н    | L      | BA, A10     | PRE/PALL   | ILLEGAL  | 3     |
|                                 | L   | L    | L    | Н      | ×           | REF/SELF   | ILLEGAL  |       |
|                                 | L   | L    | L    | L      | Op-Code     | MRS  | ILLEGAL  |       |
| Write with auto H × × precharge |     | ×    | ×    | ×      | DESL        | Continue burst to end $\rightarrow$ Write recovering with auto precharge |  |       |
|                                 | L   | н    | н    | н      | ×           | NOP  | Continue burst to end $\rightarrow$ Write recovering with auto precharge |       |
|                                 | L   | н    | н    | L      | ×           | BST  | ILLEGAL  |       |
|                                 | L   | н    | L    | Н      | BA, CA, A10 | READ/READA   | ILLEGAL  | 3     |
|                                 | L   | н    | L    | L      | BA, CA, A10 | WRIT/WRITA   | ILLEGAL  | 3     |
|                                 | L   | L    | н    | Н      | BA, RA      | ACT  | ILLEGAL  | 3     |
|                                 | L   | L    | н    | L      | BA, A10     | PRE/PALL   | ILLEGAL  | 3     |
|                                 | L   | L    | L    | Н      | ×           | REF/SELF   | ILLEGAL  |       |
|                                 | L   | L    | L    | L      | Op-Code     | MRS  | ILLEGAL  |       |
| Precharging                     | н   | ×    | ×    | ×      | ×           | DESL   | Nop $\rightarrow$ Enter idle after trep                                  |       |
|                                 | L   | н    | н    | н      | ×           | NOP  | $Nop \to Enter \ idle \ after \ t_{RP}$                                  |       |
|                                 | L   | н    | Н    | L      | ×           | BST  | ILLEGAL  |       |
|                                 | L   | н    | L    | Н      | BA, CA, A10 | READ/READA   | ILLEGAL  | 3     |
|                                 | L   | Н    | L    | L      | BA, CA, A10 | WRIT/WRITA   | ILLEGAL  | 3     |
|                                 | L   | L    | н    | н      | BA, RA      | ACT  | ILLEGAL  | 3     |
|                                 | L   | L    | н    | L      | BA, A10     | PRE/PALL   | Nop $\rightarrow$ Enter idle after t <sub>RP</sub>                       |       |
|                                 | L   | L    | L    | н      | ×           | REF/SELF   | ILLEGAL  |       |
|                                 | L   | L    | L    | L      | Op-Code     | MRS  | ILLEGAL  |       |
| Row activating                  | Н   | ×    | ×    | ×      | ×           | DESL   | Nop $\rightarrow$ Enter bank active after trcd                           |       |
|                                 | L   | н    | н    | н      | ×           | NOP  | Nop $\rightarrow$ Enter bank active after trop                           |       |
|                                 | L   | н    | Н    | L      | ×           | BST  | ILLEGAL  |       |
|                                 | L   | н    | L    | Н      | BA, CA, A10 | READ/READA   | ILLEGAL  | 3     |
|                                 | L   | н    | L    | L      | BA, CA, A10 | WRIT/WRITA   | ILLEGAL  | 3     |
|                                 | L   | L    | н    | н      | BA, RA      | ACT  | ILLEGAL  | 3, 10 |
|                                 | L   | L    | н    | L      | BA, A10     | PRE/PALL   | ILLEGAL  | 3     |
|                                 | L   | L    | L    | -<br>H | ×           | REF/SELF   | ILLEGAL  | -     |
|                                 | L   | L    | L    | L      | Op-Code     | MRS  | ILLEGAL  |       |

| Current state       | /CS | /DAC | /CAS | /WE    | Address                    | Command                       | Action   | (3/3)<br>Notes |
|---------------------|-----|------|------|--------|----------------------------|-------------------------------|--|----------------|
| Write recovering    | H   | X    | X    | X      | ×                          | DESL                          | Nop $\rightarrow$ Enter row active after topl  | Notes          |
| white recovering    |     | ́н   | ́н   | ́н     | ×                          | NOP                           | Nop $\rightarrow$ Enter row active after topl<br>Nop $\rightarrow$ Enter row active after topl |                |
|                     |     | н    | н    | L      | ×                          | BST                           | Nop $\rightarrow$ Enter row active after tope<br>Nop $\rightarrow$ Enter row active after tope |                |
|                     | L   | н    | L    | н<br>Н | ^<br>BA, CA, A10           | READ/READA                    | Start read, Determine AP   | 8              |
|                     |     | н    | L    | L      | BA, CA, A10<br>BA, CA, A10 | WRIT/WRITA                    | New write, Determine AP  | 0              |
|                     |     | L    | Н    | Н      | BA, CA, A10<br>BA, RA      | ACT                           | ILLEGAL  | 3              |
|                     | L   | L    | н    | L      | BA, A10                    | PRE/PALL                      | ILLEGAL  | 3              |
|                     | L   | L    | L    | Н      | X                          | REF/SELF                      | ILLEGAL  |                |
|                     | L   |      | L    | L      | ^<br>Op-Code               | MRS                           | ILLEGAL  |                |
| Write recovering    | н   | ×    | ×    | ×      | ×                          | DESL                          | Nop $\rightarrow$ Enter precharge after topl   |                |
| with auto precharge |     | ́н   | ́н   | ́н     | ×                          | NOP                           | Nop $\rightarrow$ Enter precharge after topl   |                |
| with auto precharge |     | н    | н    | L      |                            | BST                           | Nop $\rightarrow$ Enter precharge after topl   |                |
|                     | L   | п    |      | н      | ×                          | READ/READA                    | $NOp \rightarrow Enter precharge after topic$  | 2.0            |
|                     |     |      | L    |        | BA, CA, A10                |                               |  | 3, 8           |
|                     | L   | н    | L    | L      | BA, CA, A10                | WRIT/WRITA                    | ILLEGAL  | 3              |
|                     | L   | L    | н    | н      | BA, RA                     | ACT                           | ILLEGAL  | 3              |
|                     | L   | L    | н    | L      | BA, A10                    | PRE/PALL                      | ILLEGAL  |                |
|                     | L   | L    | L    | Н      | ×                          | REF/SELF                      | ILLEGAL  |                |
|                     | L   | L    | L    | L      | Op-Code                    | MRS                           | ILLEGAL  |                |
| Refreshing          | Н   | ×    | ×    | ×      | Х                          | DESL                          | Nop $\rightarrow$ Enter idle after tRC   |                |
|                     | L   | Н    | Н    | ×      | ×                          | NOP/BST                       | Nop $\rightarrow$ Enter idle after t <sub>RC</sub>   |                |
|                     | L   | Н    | L    | ×      | ×                          | READ/WRIT                     | ILLEGAL  |                |
|                     | L   | L    | Н    | ×      | ×                          | ACT/PRE/PALL                  | ILLEGAL  |                |
|                     | L   | L    | L    | ×      | ×                          | REF/SELF/MRS                  | ILLEGAL  |                |
| Mode register       | н   | ×    | ×    | ×      | ×                          | DESL                          | $Nop \rightarrow Enter \ idle \ after \ t_{\text{RSC}}$  |                |
| accessing           | L   | Н    | н    | Н      | ×                          | NOP                           | $Nop \rightarrow Enter \ idle \ after \ t_{\text{RSC}}$  |                |
|                     | L   | Н    | Н    | L      | ×                          | BST                           | ILLEGAL  |                |
|                     | L   | н    | L    | ×      | ×                          | READ/WRIT                     | ILLEGAL  |                |
|                     | L   | L    | ×    | ×      | ×                          | ACT/PRE/PALL/<br>REF/SELF/MRS | ILLEGAL  |                |

Notes 1. All entries assume that CKE was active (High level) during the preceding clock cycle.

- If all banks are idle, and CKE is inactive (Low level), μPD45128xxx will enter Power down mode. All input buffers except CKE will be disabled.
- **3.** Illegal to bank in specified states; Function may be legal in the bank indicated by Bank Address (BA), depending on the state of that bank.
- **4.** If all banks are idle, and CKE is inactive (Low level), μPD45128xxx will enter Self refresh mode. All input buffers except CKE will be disabled.
- 5. Illegal if tRCD is not satisfied.
- 6. Illegal if tRAS is not satisfied.
- 7. Must satisfy burst interrupt condition.
- 8. Must satisfy bus contention, bus turn around, and/or write recovery requirements.
- 9. Must mask preceding data which don't satisfy tDPL.
- **10.** Illegal if tRRD is not satisfied.

Remark H = High level, L = Low level, × = High or Low level (Don't care), V = Valid data

| Current State         | C     | KE | /CS | /RAS | /CAS | /WE | Address | Action   | Note |
|-----------------------|-------|----|-----|------|------|-----|---------|--|------|
|                       | n – 1 | n  |     |      |      |     |         |  |      |
| Self refresh          | н     | ×  | ×   | ×    | ×    | ×   | ×       | INVALID, CLK (n – 1) would exit self refresh   |      |
|                       | L     | н  | н   | ×    | ×    | ×   | ×       | Self refresh recovery                          |      |
|                       | L     | н  | L   | н    | н    | ×   | ×       | Self refresh recovery                          |      |
|                       | L     | н  | L   | н    | L    | ×   | ×       | ILLEGAL  |      |
|                       | L     | Н  | L   | L    | ×    | ×   | ×       | ILLEGAL  |      |
|                       | L     | L  | ×   | ×    | ×    | ×   | ×       | Maintain self refresh                          |      |
| Self refresh recovery | н     | н  | н   | ×    | ×    | ×   | ×       | Idle after tRc                                 |      |
|                       | Н     | Н  | L   | Н    | Н    | ×   | ×       | Idle after tRC                                 |      |
|                       | н     | н  | L   | н    | L    | ×   | ×       | ILLEGAL  |      |
|                       | н     | н  | L   | L    | ×    | ×   | ×       | ILLEGAL  |      |
|                       | н     | L  | Н   | ×    | ×    | ×   | ×       | ILLEGAL  |      |
|                       | н     | L  | L   | н    | н    | ×   | ×       | ILLEGAL  |      |
|                       | н     | L  | L   | н    | L    | ×   | ×       | ILLEGAL  |      |
|                       | н     | L  | L   | L    | ×    | ×   | ×       | ILLEGAL  |      |
| Power down            | н     | ×  | ×   | ×    | ×    | ×   |         | INVALID, CLK (n – 1) would exit power down     |      |
|                       | L     | н  | н   | ×    | ×    | ×   | ×       | EXIT power down $\rightarrow$ Idle             |      |
|                       | L     | н  | L   | н    | н    | н   | ×       | EXIT power down $\rightarrow$ Idle             |      |
|                       | L     | L  | ×   | ×    | ×    | ×   | ×       | Maintain power down mode                       |      |
| All banks idle        | н     | н  | Н   | ×    | ×    | ×   |         | Refer to operations in Operative Command Table |      |
|                       | н     | Н  | L   | н    | ×    | ×   |         | Refer to operations in Operative Command Table |      |
|                       | н     | н  | L   | L    | н    | ×   |         | Refer to operations in Operative Command Table |      |
|                       | н     | н  | L   | L    | L    | Н   | ×       | CBR (auto) Refresh                             |      |
|                       | н     | н  | L   | L    | L    | L   | Op-Code | Refer to operations in Operative Command Table |      |
|                       | н     | L  | н   | ×    | ×    | ×   |         | Refer to operations in Operative Command Table |      |
|                       | н     | L  | L   | н    | ×    | ×   |         | Refer to operations in Operative Command Table |      |
|                       | н     | L  | L   | L    | Н    | ×   |         | Refer to operations in Operative Command Table |      |
|                       | н     | L  | L   | L    | L    | Н   | ×       | Self refresh                                   | 1    |
|                       | н     | L  | L   | L    | L    | L   | Op-Code | Refer to operations in Operative Command Table |      |
|                       | L     | ×  | ×   | ×    | ×    | ×   | ×       | Power down                                     | 1    |
| Row active            | н     | ×  | ×   | ×    | ×    | ×   | ×       | Refer to operations in Operative Command Table |      |
|                       | L     | ×  | ×   | ×    | ×    | ×   | ×       | Power down                                     | 1    |
| Any state other than  | н     | Н  | ×   | ×    | ×    | ×   |         | Refer to operations in Operative Command Table |      |
| listed above          | н     | L  | ×   | ×    | ×    | ×   | ×       | Begin clock suspend next cycle                 | 2    |
|                       | L     | Н  | ×   | ×    | ×    | ×   | ×       | Exit clock suspend next cycle                  |      |
|                       | L     | L  | ×   | ×    | ×    | ×   | ×       | Maintain clock suspend                         | 1    |

## 4.5 Command Truth Table for CKE

**Notes 1.** Self refresh can be entered only from the all banks idle state. Power down can be entered only from all banks idle or row active state.

2. Must be legal command as defined in Operative Command Table.

**Remark** H = High level, L = Low level, × = High or Low level (Don't care)

## 5. Initialization

The synchronous DRAM is initialized in the power-on sequence according to the following.

- (1) To stabilize internal circuits, when power is applied, a 100  $\mu$ s or longer pause must precede any signal toggling.
- (2) After the pause, all banks must be precharged using the Precharge command (The Precharge all banks command is convenient).
- (3) Once the precharge is completed and the minimum tRP is satisfied, the mode register can be programmed. After the mode register set cycle, tRsc (2 CLK minimum) pause must be satisfied as well.
- (4) Two or more CBR (Auto) refresh must be performed.
- Remarks 1. The sequence of Mode register programming and Refresh above may be transposed.2. CKE and DQM must be held high until the Precharge command is issued to ensure data-bus Hi-Z.

## 6. Programming the Mode Register

The mode register is programmed by the Mode register set command using address bits A11 through A0, BA0(A13) and BA1(A12) as data inputs. The register retains data until it is reprogrammed or the device loses power.

The mode register has four fields;

Options: A11 through A7, BA0(A13), BA1(A12)/CAS latency: A6 through A4Wrap type: A3Burst length: A2 through A0

Following mode register programming, no command can be issued before at least 2 CLK have elapsed.

#### /CAS Latency

/CAS latency is the most critical of the parameters being set. It tells the device how many clocks must elapse before the data will be available.

The value is determined by the frequency of the clock and the speed grade of the device. **13.3 Relationship between Frequency and Latency** shows the relationship of /CAS latency to the clock period and the speed grade of the device.

## **Burst Length**

Burst Length is the number of words that will be output or input in a read or write cycle. After a read burst is completed, the output bus will become Hi-Z.

The burst length is programmable as 1, 2, 4, 8 or full page.

## Wrap Type (Burst Sequence)

The wrap type specifies the order in which the burst data will be addressed. This order is programmable as either "Sequential" or "Interleave". The method chosen will depend on the type of CPU in the system.

Some microprocessor cache systems are optimized for sequential addressing and others for interleaved addressing. **7.1 Burst Length and Sequence** shows the addressing sequence for each burst length using them. Both sequences support bursts of 1, 2, 4 and 8. Additionally, sequence supports the full page length.

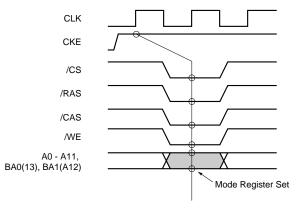
## 7. Mode Register

|       | BA1<br>(A12) | A11 | A10 | A9 | A8 | A7 | A6 | A5   | A4 | A3 | A2 | A1 | A0   |           |             |                   |                 |
|-------|--------------|-----|-----|----|----|----|----|------|----|----|----|----|------|-----------|-------------|-------------------|-----------------|
| 0     | 0            | 0   | 0   | 0  | 0  | 1  |    |      |    |    |    |    |      | JEDEC     | Standard T  | est Set (refresh  | o counter test) |
|       | BA1<br>(A12) | A11 | A10 | A9 | A8 | A7 | A6 | A5   | A4 | A3 | A2 | A1 | A0   |           |             |                   |                 |
| х     | х            | х   | х   | 1  | 0  | 0  | L  | TMOE | E  | WT |    | BL |      |           | ad and Sir  |                   |                 |
|       | BA1          |     |     |    |    |    |    |      |    |    |    |    |      | (for Writ | e Through   | Cache)            |                 |
| (A13) | (A12)        | A11 | A10 | A9 | A8 | A7 | A6 | A5   | A4 | A3 | A2 | A1 | A0   |           |             |                   |                 |
|       |              |     |     |    | 1  | 0  |    |      |    |    |    |    |      | Use in fu | uture       |                   |                 |
|       | BA1<br>(A12) | A11 | A10 | A9 | A8 | A7 | A6 | A5   | A4 | A3 | A2 | A1 | A0   |           |             |                   |                 |
| х     | х            | х   | x   | х  | 1  | 1  | V  | V    | V  | V  | V  | V  | V    | Vender    | Specific    |                   |                 |
| BA0   | BA1          |     |     |    |    | 1  |    |      |    |    |    |    |      |           |             |                   | V = Valid       |
|       | (A12)        | A11 | A10 | A9 | A8 | A7 | A6 | A5   | A4 | A3 | A2 | A1 | A0   |           |             |                   | x = Don't care  |
| 0     | 0            | 0   | 0   | 0  | 0  | 0  | L  | TMOD | E  | WT |    | BL |      | Mode R    | egister Set |                   |                 |
|       |              |     |     |    |    |    |    |      |    |    |    | F  |      |           | Bits2-0     | WT = 0            | WT = 1          |
|       |              |     |     |    |    |    |    |      |    |    |    |    |      |           | 000         | 1                 | 1               |
|       |              |     |     |    |    |    |    |      |    |    |    |    |      |           | 001         | 2 4               | 2 4             |
|       |              |     |     |    |    |    |    |      |    |    |    |    | Bur  | at length | 010         | 8                 | 8               |
|       |              |     |     |    |    |    |    |      |    |    |    |    | Duit | sciongui  | 100         |                   | R               |
|       |              |     |     |    |    |    |    |      |    |    |    |    |      |           | 101         | R                 | R               |
|       |              |     |     |    |    |    |    |      |    |    |    |    |      |           | 110         | R                 | R               |
|       |              |     |     |    |    |    |    |      |    |    |    | L  |      |           | 111         | Full page         | R               |
|       |              |     |     |    |    |    |    |      |    |    |    | [  | Wra  | ap type   |             | uential<br>rleave |                 |
|       |              |     |     |    |    |    |    |      |    |    |    |    |      |           |             | s6-4 /CAS lat     |                 |

|         | Bits6-4 | /CAS latency |
|---------|---------|--------------|
|         | 000     | R            |
|         | 001     | R            |
|         | 010     | 2            |
| Latency | 011     | 3            |
| mode    | 100     | R            |
|         | 101     | R            |
|         | 110     | R            |
|         | 111     | R            |

Remark R : Reserved

## Mode Register Set Timing



Data Sheet E0031N30

## 7.1 Burst Length and Sequence

## [Burst of Two]

| Starting address<br>(column address A0, binary) | Sequential addressing sequence (decimal) | Interleave addressing sequence<br>(decimal) |  |  |  |
|---|--|---|--|--|--|
| 0   | 0, 1                                     | 0, 1  |  |  |  |
| 1   | 1, 0                                     | 1, 0  |  |  |  |

## [Burst of Four]

| Starting address<br>(column address A1 - A0, binary) | Sequential addressing sequence<br>(decimal) | Interleave addressing sequence<br>(decimal) |  |  |  |
|--|---|---|--|--|--|
| 00   | 0, 1, 2, 3                                  | 0, 1, 2, 3                                  |  |  |  |
| 01   | 1, 2, 3, 0                                  | 1, 0, 3, 2                                  |  |  |  |
| 10   | 2, 3, 0, 1                                  | 2, 3, 0, 1                                  |  |  |  |
| 11   | 3, 0, 1, 2                                  | 3, 2, 1, 0                                  |  |  |  |

## [Burst of Eight]

| Starting address<br>(column address A2 - A0, binary) | Sequential addressing sequence (decimal) | Interleave addressing sequence<br>(decimal) |
|--|--|---|
| 000  | 0, 1, 2, 3, 4, 5, 6, 7                   | 0, 1, 2, 3, 4, 5, 6, 7                      |
| 001  | 1, 2, 3, 4, 5, 6, 7, 0                   | 1, 0, 3, 2, 5, 4, 7, 6                      |
| 010  | 2, 3, 4, 5, 6, 7, 0, 1                   | 2, 3, 0, 1, 6, 7, 4, 5                      |
| 011  | 3, 4, 5, 6, 7, 0, 1, 2                   | 3, 2, 1, 0, 7, 6, 5, 4                      |
| 100  | 4, 5, 6, 7, 0, 1, 2, 3                   | 4, 5, 6, 7, 0, 1, 2, 3                      |
| 101  | 5, 6, 7, 0, 1, 2, 3, 4                   | 5, 4, 7, 6, 1, 0, 3, 2                      |
| 110  | 6, 7, 0, 1, 2, 3, 4, 5                   | 6, 7, 4, 5, 2, 3, 0, 1                      |
| 111  | 7, 0, 1, 2, 3, 4, 5, 6                   | 7, 6, 5, 4, 3, 2, 1, 0                      |

Full page burst is an extension of the above tables of sequential addressing, with the length being 2,048 (for  $32M \times 4$  device), 1,024 (for  $16M \times 8$  device), and 512 (for  $8M \times 16$  device).

enables Read/Write

commands for Bank B enables Read/Write

commands for Bank C enables Read/Write commands for Bank D

0

1

1

1

0

1

## 8. Address Bits of Bank-Select and Precharge

| Row           | A0      | A1    | A2 | A3 | A4 | A5 | A6 | A7 | A8 | A9 | A10 | A11 | BA1<br>(A12) | BA0<br>(A13) | BA1(A12) | BA0(A13)                              | Resu                 | ult                              |  |  |
|---------------|---------|-------|----|----|----|----|----|----|----|----|-----|-----|--------------|--------------|----------|---------------------------------------|----------------------|----------------------------------|--|--|
| L<br>(Activat | te com  | mand) |    |    |    |    |    | 1  |    |    | 1   |     |              |              | 0        | 0 Select Bank A<br>"Activate" command |                      |                                  |  |  |
|               |         |       |    |    |    |    |    |    |    |    |     |     |              |              | 0        | 1                                     |                      | Bank B<br>ate" command           |  |  |
|               |         |       |    |    |    |    |    |    |    |    |     |     |              |              | 1        | 0                                     |                      | Bank C<br>ate" command           |  |  |
|               |         |       |    |    |    |    |    |    |    |    |     |     |              |              | 1        | 1                                     |                      | Bank D<br>ate" command           |  |  |
|               |         |       |    |    |    |    |    |    |    |    |     |     |              |              |          |                                       |                      |                                  |  |  |
|               | A0      | A1    | A2 | A3 | A4 | A5 | A6 | A7 | A8 | A9 | A10 | A11 | BA1<br>(A12) | BA0<br>(A13) |          |                                       |                      |                                  |  |  |
| (Precha       | arde co | mman  | d) |    |    |    |    |    |    |    |     |     |              | ,            | A10      | BA1(A12)                              | BA0(A13)             | Result                           |  |  |
| (             |         |       | -) |    |    |    |    |    |    |    |     |     |              |              | 0        | 0                                     | 0                    | Precharge Bank A                 |  |  |
|               |         |       |    |    |    |    |    |    |    |    |     |     |              |              | 0        | 0                                     | 1                    | Precharge Bank B                 |  |  |
|               |         |       |    |    |    |    |    |    |    |    |     |     |              |              | 0        | 1                                     | 0                    | Precharge Bank C                 |  |  |
|               |         |       |    |    |    |    |    |    |    |    |     |     |              |              | 0        | 1                                     | 1                    | Precharge Bank D                 |  |  |
|               |         |       |    |    |    |    |    |    |    |    |     |     |              |              | 1        | x                                     | х                    | Precharge All Banks              |  |  |
|               |         |       |    |    |    |    |    |    |    |    |     |     |              |              |          | x : Dor                               | i't care             |                                  |  |  |
|               |         |       |    |    |    |    |    |    |    |    |     |     |              | ,            | - 0      |                                       | les Auto<br>of Burst | p-Precharge<br>)                 |  |  |
| Col.          | A0      | A1    | A2 | A3 | A4 | A5 | A6 | A7 | A8 | A9 | A10 | x   | BA1<br>(A12) | BA0<br>(A13) | 1        |                                       | es Auto<br>of Burst  | -Precharge<br>)                  |  |  |
| (/CAS s       | strobes | ;)    |    |    |    |    |    |    |    |    |     |     |              |              |          |                                       |                      |                                  |  |  |
|               |         |       |    |    |    |    |    |    |    |    |     |     |              |              | BA1(A12) | BA0(A13)                              |                      |                                  |  |  |
|               |         |       |    |    |    |    |    |    |    |    |     |     |              |              | 0        | 0                                     |                      | es Read/Write<br>ands for Bank A |  |  |

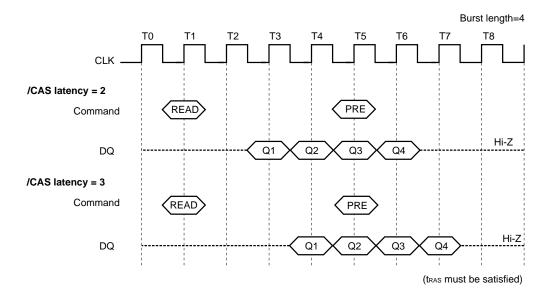
## 9. Precharge

The precharge command can be issued anytime after tras (MIN.) is satisfied.

Soon after the precharge command is issued, precharge operation performed and the synchronous DRAM enters the idle state after trep is satisfied. The parameter trep is the time required to perform the precharge.

The earliest timing in a read cycle that a precharge command can be issued without losing any data in the burst is as follows.

It is depending on the /CAS latency and clock cycle time.



In order to write all data to the memory cell correctly, the asynchronous parameter "topt" must be satisfied. The topt (MIN.) specification defines the earliest time that a precharge command can be issued. Minimum number of clocks is calculated by dividing topt (MIN.) with clock cycle time.

In summary, the precharge command can be issued relative to reference clock that indicates the last data word is valid. In the following table, minus means clocks before the reference; plus means time after the reference.

| /CAS latency | Read | Write        |  |  |
|--------------|------|--------------|--|--|
| 2            | -1   | +tdpl (MIN.) |  |  |
| 3            | -2   | +tDPL (MIN.) |  |  |

## 10. Auto Precharge

During a read or write command cycle, A10 controls whether auto precharge is selected. A10 high in the Read or Write command (Read with Auto precharge command or Write with Auto precharge command), auto precharge is selected and begins automatically.

The tras must be satisfied with a read with auto precharge or a write with auto precharge operation. In addition, the next activate command to the bank being precharged cannot be executed until the precharge cycle ends.

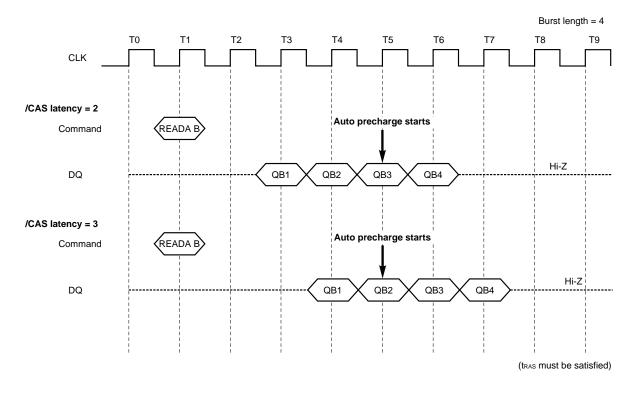
In read cycle, once auto precharge has started, an activate command to the bank can be issued after tRP has been satisfied.

In write cycle, the tDAL must be satisfied to issue the next activate command to the bank being precharged.

The timing that begins the auto precharge cycle depends on both the /CAS latency programmed into the mode register and whether read or write cycle.

#### 10.1 Read with Auto Precharge

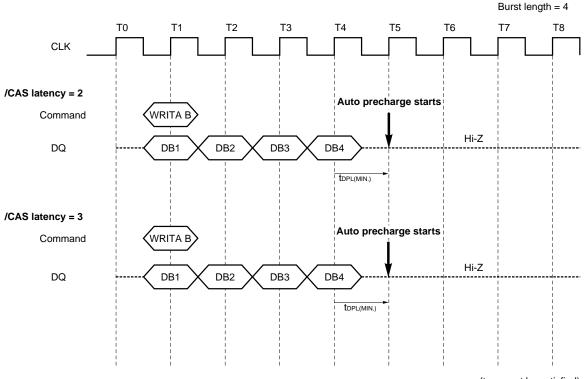
During a read cycle, the auto precharge begins one clock earlier (/CAS latency of 2) or two clocks earlier (/CAS latency of 3) the last data word output.



Remark READA means Read with Auto precharge

## 10.2 Write with Auto Precharge

During a write cycle, the auto precharge starts at the timing that is equal to the value of the tDPL (MIN.) after the last data word input to the device.



(tras must be satisfied)

#### Remark WRITA means Write with Auto Precharge

In summary, the auto precharge begins relative to a reference clock that indicates the last data word is valid. In the table below, minus means clocks before the reference; plus means after the reference.

| /CAS latency | Read | Write        |  |  |
|--------------|------|--------------|--|--|
| 2            | -1   | +tdpl (MIN.) |  |  |
| 3            | -2   | +tDPL (MIN.) |  |  |

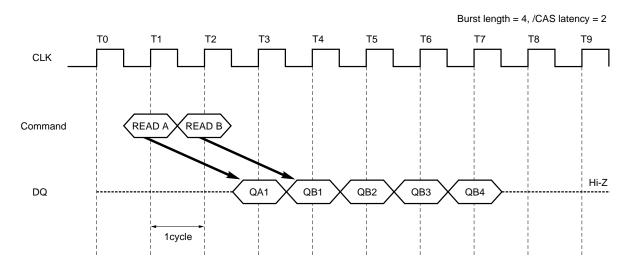
**ELPID**A

## 11. Read / Write Command Interval

#### 11.1 Read to Read Command Interval

During a read cycle, when new Read command is issued, it will be effective after /CAS latency, even if the previous read operation does not completed. READ will be interrupted by another READ.

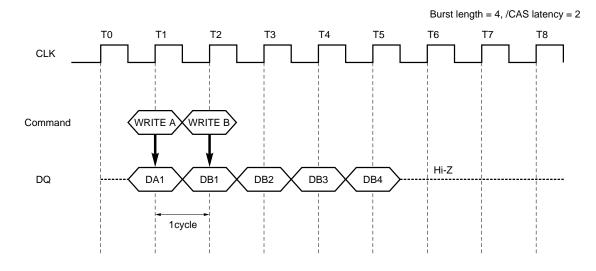
The interval between the commands is 1 cycle minimum. Each Read command can be issued in every clock without any restriction.



#### 11.2 Write to Write Command Interval

During a write cycle, when a new Write command is issued, the previous burst will terminate and the new burst will begin with a new Write command. WRITE will be interrupted by another WRITE.

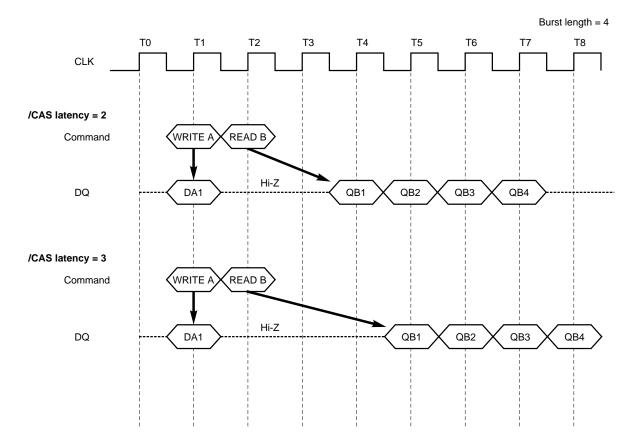
The interval between the commands is minimum 1 cycle. Each Write command can be issued in every clock without any restriction.



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## 11.3 Write to Read Command Interval

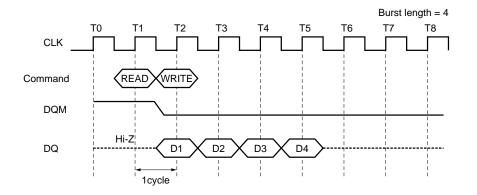
Write command and Read command interval is also 1 cycle. Only the write data before Read command will be written. The data bus must be Hi-Z at least one cycle prior to the first Dout.



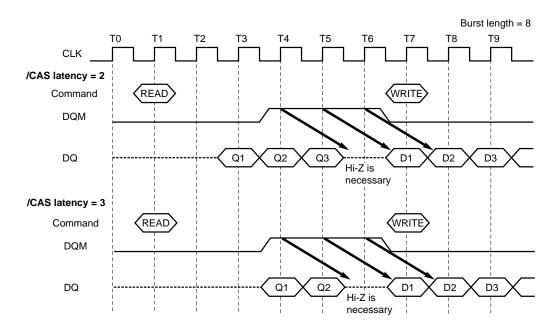
## 11.4 Read to Write Command Interval

During a read cycle, READ can be interrupted by WRITE.

The Read and Write command interval is 1 cycle minimum. There is a restriction to avoid data conflict. The Data bus must be Hi-Z using DQM before WRITE.



READ can be interrupted by WRITE. DQM must be High at least 3 clocks prior to the Write command.

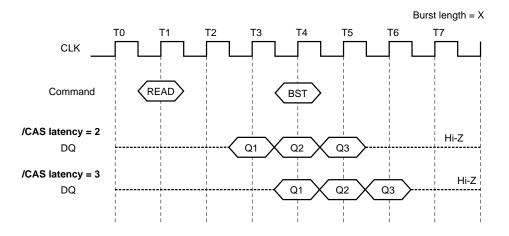


## 12. Burst Termination

There are two methods to terminate a burst operation other than using a Read or a Write command. One is the burst stop command and the other is the precharge command.

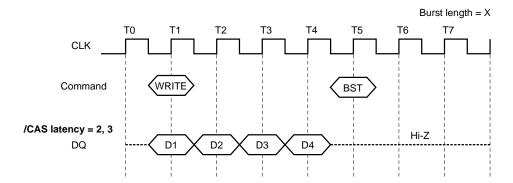
## 12.1 Burst Stop Command

During a read cycle, when the burst stop command is issued, the burst read data are terminated and the data bus goes to Hi-Z after the /CAS latency from the burst stop command.



Remark BST: Burst stop command

During a write cycle, when the burst stop command is issued, the burst write data are terminated and data bus goes to Hi-Z at the same clock with the burst stop command.



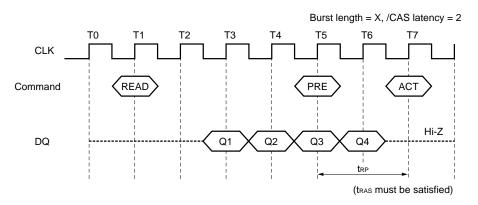
Remark BST: Burst stop command

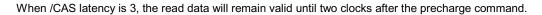
#### 12.2 Precharge Termination

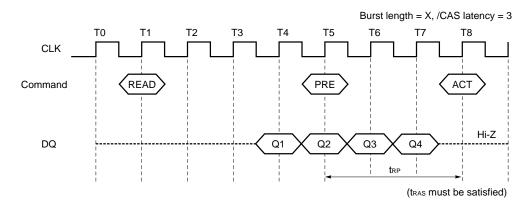
## 12.2.1 Precharge Termination in READ Cycle

During a read cycle, the burst read operation is terminated by a precharge command. When the precharge command is issued, the burst read operation is terminated and precharge starts. The same bank can be activated again after t<sub>RP</sub> from the precharge command. To issue a precharge command, t<sub>RAS</sub> must be satisfied.

When /CAS latency is 2, the read data will remain valid until one clock after the precharge command.



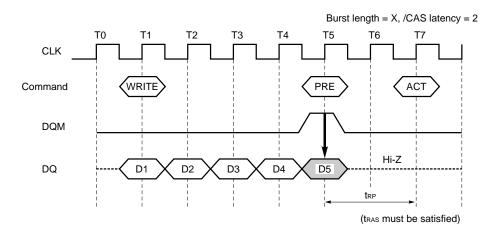




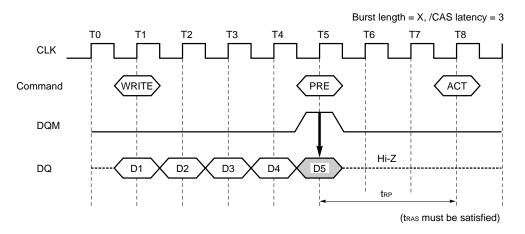
#### 12.2.2 Precharge Termination in WRITE Cycle

During a write cycle, the burst write operation is terminated by a precharge command. When the precharge command is issued, the burst write operation is terminated and precharge starts. The same bank can be activated again after trep from the precharge command. To issue a precharge command, tras must be satisfied.

When /CAS latency is 2, the write data written prior to the precharge command will be correctly stored. However, invalid data may be written at the same clock as the precharge command. To prevent this from happening, DQM must be high at the same clock as the precharge command. This will mask the invalid data.



When /CAS latency is 3, the write data written prior to the precharge command will be correctly stored. However, invalid data may be written at the same clock as the precharge command. To prevent this from happening, DQM must be high at the same clock as the precharge command. This will mask the invalid data.



## 13. Electrical Specifications

- All voltages are referenced to Vss (GND).
- After power up, wait more than 100 µs and then, execute **Power on sequence and CBR (auto) Refresh** before proper device operation is achieved.

## Absolute Maximum Ratings

| Parameter                                   | Symbol    | Condition | Rating       | Unit |
|---|-----------|-----------|--------------|------|
| Voltage on power supply pin relative to GND | Vcc, VccQ |           | –0.5 to +4.6 | V    |
| Voltage on any pin relative to GND          | VT        |           | –0.5 to +4.6 | V    |
| Short circuit output current                | lo        |           | 50           | mA   |
| Power dissipation                           | PD        |           | 1            | W    |
| Operating ambient temperature               | TA        |           | 0 to 70      | °C   |
| Storage temperature                         | Tstg      |           | –55 to + 125 | °C   |

Caution Exposing the device to stress above those listed in Absolute Maximum Ratings could cause permanent damage. The device is not meant to be operated under conditions outside the limits described in the operational section of this specification. Exposure to Absolute Maximum Rating conditions for extended periods may affect device reliability.

## **Recommended Operating Conditions**

| Parameter                     | Symbol    | Condition | MIN.                  | TYP. | MAX.                     | Unit |
|-------------------------------|-----------|-----------|-----------------------|------|--------------------------|------|
| Supply voltage                | Vcc, VccQ |           | 3.0                   | 3.3  | 3.6                      | V    |
| High level input voltage      | Vін       |           | 2.0                   |      | Vcc+0.3 <sup>Note1</sup> | V    |
| Low level input voltage       | VIL       |           | -0.3 <sup>Note2</sup> |      | +0.8                     | V    |
| Operating ambient temperature | TA        |           | 0                     |      | 70                       | °C   |

**Notes 1.**  $V_{\text{IH (MAX.)}} = V_{\text{CC}} + 1.5 \text{ V}$  (Pulse width  $\leq 5 \text{ ns}$ )

**2.** VIL (MIN.) = -1.5 V (Pulse width  $\le 5$  ns)

## Pin Capacitance (T<sub>A</sub> = 25 °C, f = 1 MHz)

| Parameter                       | Symbol | Condition  | MIN. | TYP. | MAX. | Unit |
|---------------------------------|--------|--|------|------|------|------|
| Input capacitance               | CI1    | CLK  | 2.5  |      | 3.5  | pF   |
|                                 | Cı2    | A0 - A11, BA0(A13), BA1(A12), CKE,<br>/CS, /RAS, /CAS, /WE, DQM, UDQM,<br>LDQM | 2.5  |      | 3.8  |      |
| Data input / output capacitance | Cı/o   | DQ0 - DQ15   | 4    |      | 6.5  | pF   |

| Parameter                  | Symbol | Test condition  | /CAS                      | Grade    | Maximum |     |     | Unit | Notes |
|----------------------------|--------|---|---------------------------|----------|---------|-----|-----|------|-------|
|                            |        |   | latency                   |          | ×4      | ×8  | ×16 |      |       |
| Operating current          | Icc1   | Burst length = 1,                                     | CL = 2                    | -A75A    | 110     | 110 | 120 | mA   | 1     |
|                            |        | $t_{RC} \ge t_{RC}$ (MIN.), $I_0 = 0 \text{ mA}$ ,    |                           | -A75     | 100     | 100 | 110 |      |       |
|                            |        | One bank active                                       |                           | -A80     | 100     | 100 | 110 |      |       |
|                            |        |   |                           | -A10     | 100     | 100 | 110 |      |       |
|                            |        |   | CL = 3                    | -A75A    | 110     | 110 | 120 |      |       |
|                            |        |   |                           | -A75     | 105     | 105 | 115 |      |       |
|                            |        |   |                           | -A80     | 100     | 100 | 110 |      |       |
|                            |        |   |                           | -A10     | 100     | 100 | 110 |      |       |
| Precharge standby current  | Icc2P  | $CKE \le VIL (MAX.), tck = 15 ns$                     |                           |          | 1       | 1   | 1   | mA   |       |
| in power down mode         | Icc2PS | $CKE \leq VIL (MAX.), tck = \infty$                   |                           |          | 1       | 1   | 1   |      |       |
| Precharge standby current  | Icc2N  | СКЕ ≥ Vін (міл.), tск = 15 ns, /0                     | S ≥ VIH (N                | 11N.),   | 20      | 20  | 20  | mA   |       |
| in non power down mode     |        | Input signals are changed one t                       | ime during                | g 30 ns. |         |     |     |      |       |
|                            | Icc2NS | $CKE \ge V_{\text{IH (MIN.)}}, \text{ tck} = \infty,$ |                           |          | 8       | 8   | 8   |      |       |
|                            |        | Input signals are stable.                             |                           |          |         |     |     |      |       |
| Active standby current     | ІссзР  | $CKE \le VIL (MAX.), tck = 15 ns$                     |                           |          | 5       | 5   | 5   | mA   |       |
| in power down mode         | Icc3PS | $CKE \leq VIL (MAX.), tck = \infty$                   |                           |          | 4       | 4   | 4   |      |       |
| Active standby current     | ІссзN  | СКЕ ≥ Vін (міл.), tск = 15 ns, /0                     | $S \ge V_{\text{IH (N)}}$ | 11N.),   | 30      | 30  | 30  | mA   |       |
| in non power down mode     |        | Input signals are changed one time during 30 ns.      |                           |          |         |     |     |      |       |
| Icc3N                      |        | CKE ≥ Vih (MIN.), tck = ∞ ,                           |                           |          | 20      | 20  | 20  |      |       |
|                            |        | Input signals are stable.                             |                           |          |         |     |     |      |       |
| Operating current          | Icc4   | tск ≥ tск (міл.), lo = 0 mA,                          | CL = 2                    | -A75A    | 140     | 155 | 185 | mA   | 2     |
| (Burst mode)               |        | All banks active                                      |                           | -A75     | 105     | 120 | 145 |      |       |
|                            |        |   |                           | -A80     | 105     | 120 | 145 |      |       |
|                            |        |   |                           | -A10     | 85      | 95  | 110 |      |       |
|                            |        |   | CL = 3                    | -A75A    | 140     | 155 | 185 |      |       |
|                            |        |   |                           | -A75     | 140     | 155 | 185 |      |       |
|                            |        |   |                           | -A80     | 130     | 145 | 175 |      |       |
|                            |        |   |                           | -A10     | 110     | 125 | 140 |      |       |
| CBR (auto) refresh current | Icc5   | $t_{RC} \ge t_{RC}$ (MIN.)                            | CL = 2                    | -A75A    | 270     | 270 | 270 | mA   | 3     |
|                            |        |   |                           | -A75     | 230     | 230 | 230 |      |       |
|                            |        |   |                           | -A80     | 230     | 230 | 230 |      |       |
|                            |        |   |                           | -A10     | 230     | 230 | 230 |      |       |
|                            |        |   | CL = 3                    | -A75A    | 270     | 270 | 270 |      |       |
|                            |        |   |                           | -A75     | 240     | 240 | 240 |      |       |
|                            |        |   |                           | -A80     | 230     | 230 | 230 |      |       |
|                            |        |   |                           | -A10     | 230     | 230 | 230 |      |       |
| Self refresh current       | Icc6   | CKE ≤ 0.2 V   |                           | -**      | 2       | 2   | 2   | mA   |       |
|                            |        |   |                           | -**L     | 0.8     | 0.8 | 0.8 | mA   |       |

## DC Characteristics 1 (Recommended Operating Conditions unless otherwise noted)

**Notes 1.** Icc1 depends on output loading and cycle rates. Specified values are obtained with the output open. In addition to this, Icc1 is measured condition that addresses are changed only one time during tck (MIN.).

- 2. Icc4 depends on output loading and cycle rates. Specified values are obtained with the output open. In addition to this, Icc4 is measured condition that addresses are changed only one time during tck (MIN.).
- 3. Iccs is measured on condition that addresses are changed only one time during tck (MIN.).

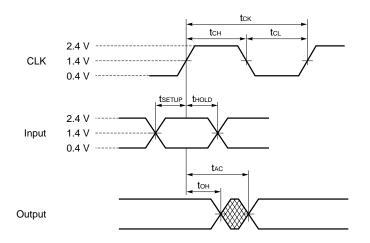
## DC Characteristics 2 (Recommended Operating Conditions unless otherwise noted)

| Parameter                 | Symbol | Test condition  | MIN. | TYP. | MAX. | Unit | Note |
|---------------------------|--------|---|------|------|------|------|------|
| Input leakage current     | lı (L) | $0 \le V_I \le V_{CC}Q$ , $V_{CC}Q = V_{CC}$<br>All other pins not under test = 0 V | -1.0 |      | +1.0 | μA   |      |
| Output leakage current    | lo (L) | $0 \le Vo \le VccQ$ , Dout is disabled  | -1.5 |      | +1.5 | μA   |      |
| High level output voltage | Vон    | lo = -4 mA  | 2.4  |      |      | V    |      |
| Low level output voltage  | Vol    | lo = +4 mA  |      |      | 0.4  | V    |      |

## AC Characteristics (Recommended Operating Conditions unless otherwise noted)

#### **Test Conditions**

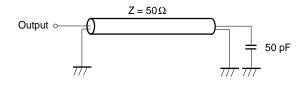
| Parameter   | Value     | Unit |
|---|-----------|------|
| AC high level input voltage / low level input voltage | 2.4 / 0.4 | V    |
| Input timing measurement reference level              | 1.4       | V    |
| Transition time (Input rise and fall time)            | 1         | ns   |
| Output timing measurement reference level             | 1.4       | V    |



### **Synchronous Characteristics**

| Parameter  |                  | Symbol           | -A75A |           | -A75 |           | -A80 |           | -A10 |           | Unit | Note |
|--|------------------|------------------|-------|-----------|------|-----------|------|-----------|------|-----------|------|------|
|  |                  |                  | MIN.  | MAX.      | MIN. | MAX.      | MIN. | MAX.      | MIN. | MAX.      |      |      |
| Clock cycle time                                 | /CAS latency = 3 | tскз             | 7.5   | (133 MHz) | 7.5  | (133 MHz) | 8    | (125 MHz) | 10   | (100 MHz) | ns   |      |
|  | /CAS latency = 2 | tck2             | 7.5   | (133 MHz) | 10   | (100 MHz) | 10   | (100 MHz) | 13   | (77 MHz)  | ns   |      |
| Access time from CLK                             | /CAS latency = 3 | t <sub>AC3</sub> |       | 5.4       |      | 5.4       |      | 6         |      | 6         | ns   | 1    |
|  | /CAS latency = 2 | tAC2             |       | 5.4       |      | 6         |      | 6         |      | 7         | ns   | 1    |
| CLK high level width                             |                  | tсн              | 2.5   |           | 2.5  |           | 3    |           | 3    |           | ns   |      |
| CLK low level width                              |                  | tc∟              | 2.5   |           | 2.5  |           | 3    |           | 3    |           | ns   |      |
| Data-out hold time                               |                  | tон              | 3     |           | 3    |           | 3    |           | 3    |           | ns   | 1    |
| Data-out low-impedance time                      |                  | t∟z              | 0     |           | 0    |           | 0    |           | 0    |           | ns   |      |
| Data-out high-impedance time                     | /CAS latency = 3 | tнzз             | 3     | 5.4       | 3    | 5.4       | 3    | 6         | 3    | 6         | ns   |      |
|  | /CAS latency = 2 | tHZ2             | 3     | 5.4       | 3    | 6         | 3    | 6         | 3    | 7         | ns   |      |
| Data-in setup time                               |                  | tos              | 1.5   |           | 1.5  |           | 2    |           | 2    |           | ns   |      |
| Data-in hold time                                |                  | tон              | 0.8   |           | 0.8  |           | 1    |           | 1    |           | ns   |      |
| Address setup time                               |                  | tas              | 1.5   |           | 1.5  |           | 2    |           | 2    |           | ns   |      |
| Address hold time                                |                  | tан              | 0.8   |           | 0.8  |           | 1    |           | 1    |           | ns   |      |
| CKE setup time                                   |                  | tcкs             | 1.5   |           | 1.5  |           | 2    |           | 2    |           | ns   |      |
| CKE hold time                                    |                  | tскн             | 0.8   |           | 0.8  |           | 1    |           | 1    |           | ns   |      |
| CKE setup time (Power down exit)                 |                  | tскяр            | 1.5   |           | 1.5  |           | 2    |           | 2    |           | ns   |      |
| Command (/CS, /RAS, /CAS, /WE, DQM) setup time   |                  | tсмs             | 1.5   |           | 1.5  |           | 2    |           | 2    |           | ns   |      |
| Command (/CS, /RAS, /CAS, /WE, DQM)<br>hold time |                  | tсмн             | 0.8   |           | 0.8  |           | 1    |           | 1    |           | ns   |      |

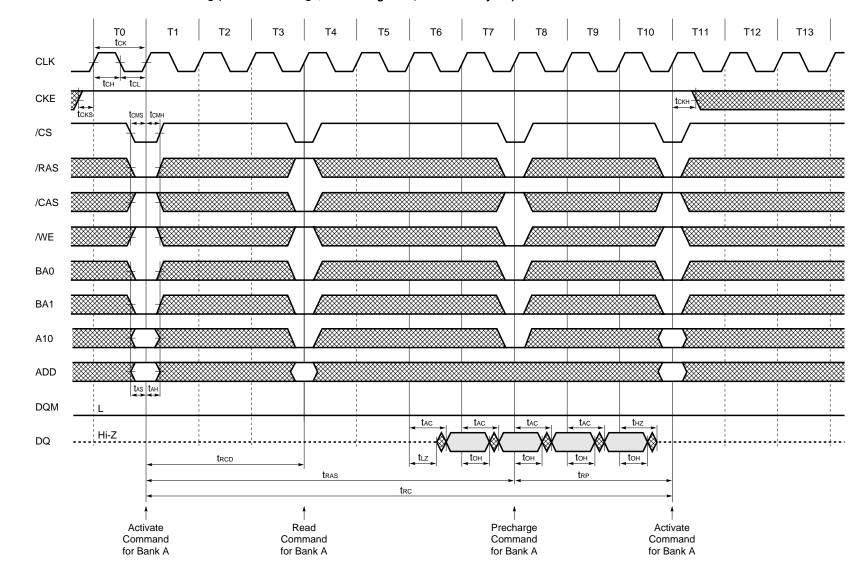
Note 1. Output load



### **Asynchronous Characteristics**

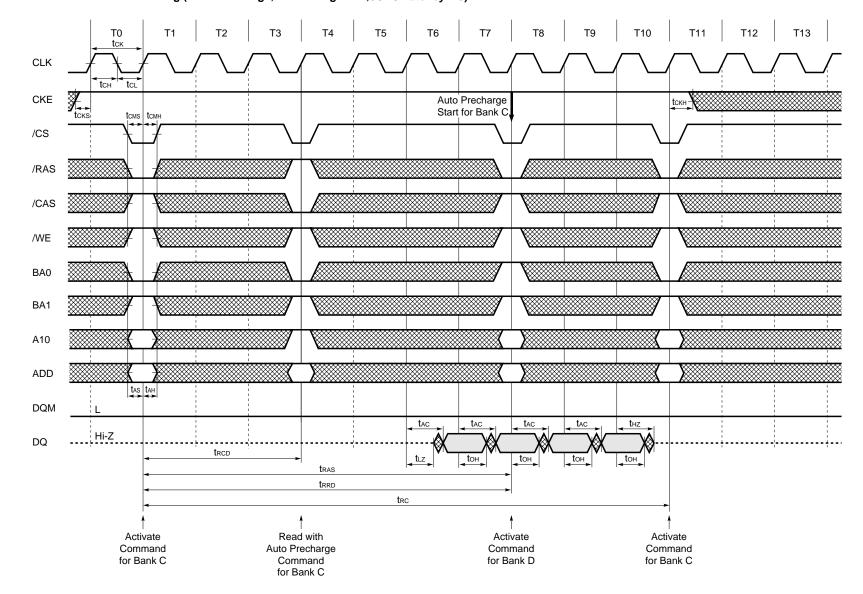
| Parameter                                 |                  | Symbol           | -A75A         |         | -A75          |         | -A80        |         | -A10        |         | Unit | Note |
|---|------------------|------------------|---------------|---------|---------------|---------|-------------|---------|-------------|---------|------|------|
|   |                  |                  | MIN.          | MAX.    | MIN.          | MAX.    | MIN.        | MAX.    | MIN.        | MAX.    |      |      |
| ACT to REF/ACT command period (operation) |                  | trc              | 60            |         | 67.5          |         | 70          |         | 70          |         | ns   |      |
| REF to REF/ACT command period (refresh)   |                  | t <sub>RC1</sub> | 60            |         | 67.5          |         | 70          |         | 70          |         | ns   |      |
| ACT to PRE command period                 |                  | tras             | 45            | 120,000 | 45            | 120,000 | 48          | 120,000 | 50          | 120,000 | ns   |      |
| PRE to ACT command period                 |                  | <b>t</b> RP      | 15            |         | 20            |         | 20          |         | 20          |         | ns   |      |
| Delay time ACT to READ/WRITE command      |                  | trcd             | 15            |         | 20            |         | 20          |         | 20          |         | ns   |      |
| ACT (one) to ACT (another) command period |                  | trrd             | 15            |         | 15            |         | 16          |         | 20          |         | ns   |      |
| Data-in to PRE command period             |                  | <b>t</b> DPL     | 8             |         | 8             |         | 8           |         | 10          |         | ns   |      |
| Data-in to ACT (REF)<br>command period    | /CAS latency = 3 | tdal3            | 1CLK<br>+22.5 |         | 1CLK<br>+22.5 |         | 1CLK<br>+20 |         | 1CLK<br>+20 |         | ns   | 1    |
| (Auto precharge)                          | /CAS latency = 2 | tdal2            | 1CLK<br>+20   |         | 1CLK<br>+20   |         | 1CLK<br>+20 |         | 1CLK<br>+20 |         | ns   |      |
| Mode register set cycle time              |                  | trsc             | 2             |         | 2             |         | 2           |         | 2           |         | CLK  |      |
| Transition time                           |                  | t⊤               | 0.5           | 30      | 0.5           | 30      | 0.5         | 30      | 1           | 30      | ns   |      |
| Refresh time (4,096 refresh cycles)       |                  | tref             |               | 64      |               | 64      |             | 64      |             | 64      | ms   |      |

**Note 1.** The –A75A and –A75 grade device can satisfy the tDAL3 spec of 1CLK+20 ns for up to and including 125MHz operation.



#### 13.1 AC Parameters for Read Timing (Manual Precharge, Burst Length = 4, /CAS Latency = 3)

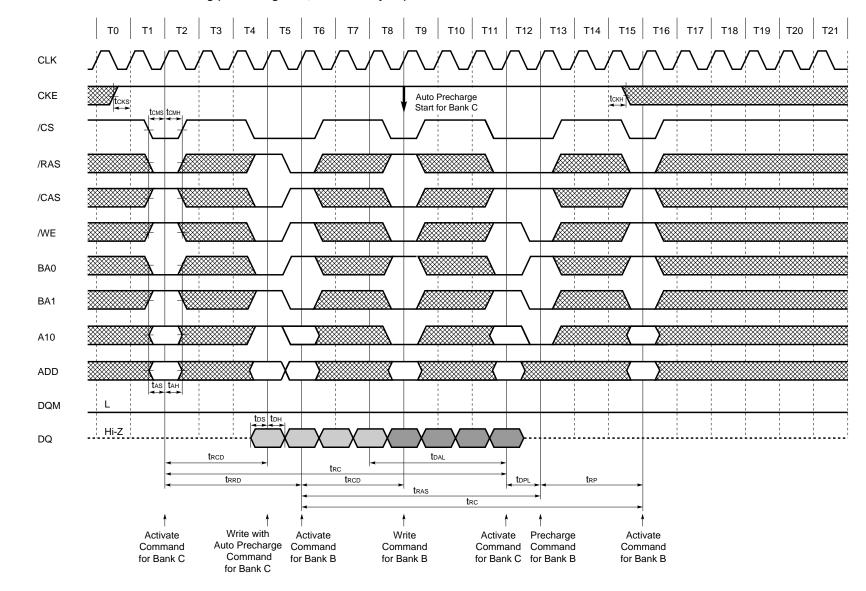
ELPIDA



## **AC** Parameters for Read Timing (Auto Precharge, Burst Length = 4, /CAS Latency = 3)

Data Sheet E0031N30

μPD45128441, 45128841, 45128163

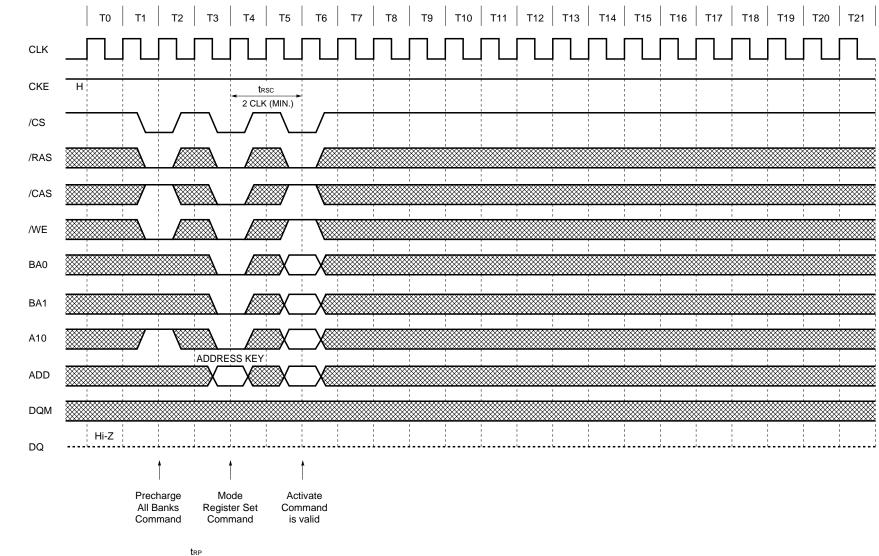


13.2 AC Parameters for Write Timing (Burst Length = 4, /CAS Latency = 3)

ELPIDA

## 13.3 Relationship between Frequency and Latency

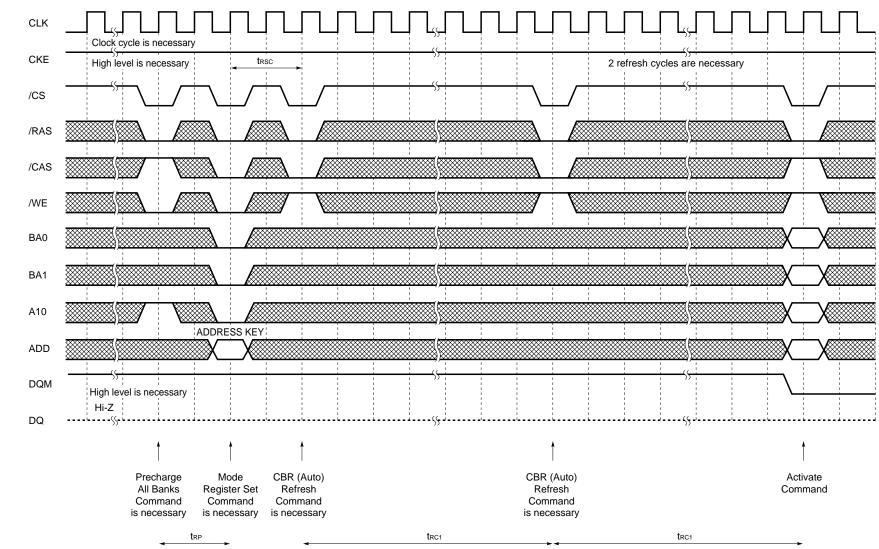
| Speed version                        |     | -75A |     | -75 | -   | ·80 | -10 |    |  |
|--------------------------------------|-----|------|-----|-----|-----|-----|-----|----|--|
| Clock cycle time [ns]                | 7.5 | 7.5  | 7.5 | 10  | 8   | 10  | 10  | 13 |  |
| Frequency [MHz]                      | 133 | 133  | 133 | 100 | 125 | 100 | 100 | 77 |  |
| /CAS latency                         | 3   | 2    | 3   | 2   | 3   | 2   | 3   | 2  |  |
| [trcd]                               | 2   | 2    | 3   | 2   | 3   | 2   | 2   | 2  |  |
| /RAS latency (/CAS latency + [trcb]) | 5   | 4    | 6   | 4   | 6   | 4   | 5   | 4  |  |
| [tRC]                                | 8   | 8    | 9   | 7   | 9   | 7   | 7   | 6  |  |
| [tRC1]                               | 8   | 8    | 9   | 7   | 9   | 7   | 8   | 6  |  |
| [tras]                               | 6   | 6    | 6   | 5   | 6   | 5   | 5   | 4  |  |
| [trrd]                               | 2   | 2    | 2   | 2   | 2   | 2   | 2   | 2  |  |
| [trp]                                | 2   | 2    | 3   | 2   | 3   | 2   | 2   | 2  |  |
| [tdpl]                               | 2   | 2    | 2   | 1   | 1   | 1   | 1   | 1  |  |
| [tdal]                               | 4   | 4    | 4   | 3   | 4   | 3   | 3   | 3  |  |
| [tRSC]                               | 2   | 2    | 2   | 2   | 2   | 2   | 2   | 2  |  |



#### 13.4 Mode Register Set (Burst Length = 4, /CAS Latency = 2)

Data Sheet E0031N30

μPD45128441, 45128841, 45128163

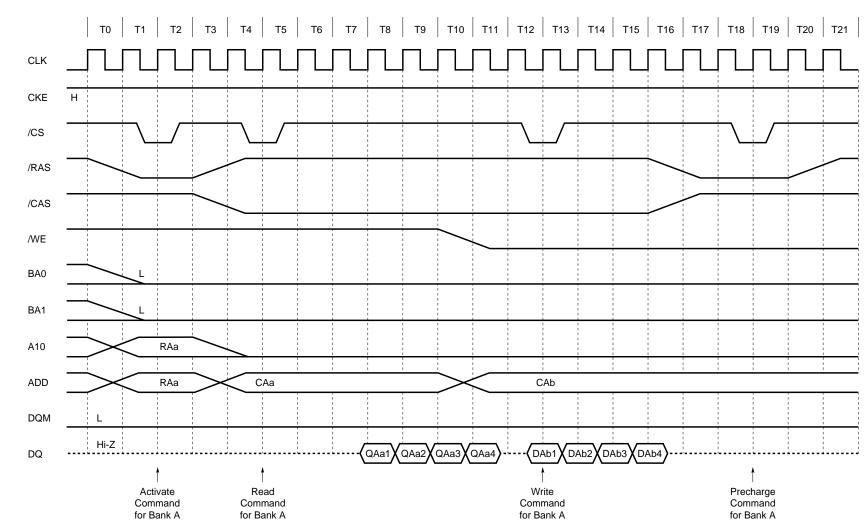


## 13.5 Power On Sequence and CBR (Auto) Refresh

Data Sheet E0031N30

μPD45128441, 45128841, 45128163

ELPIDA

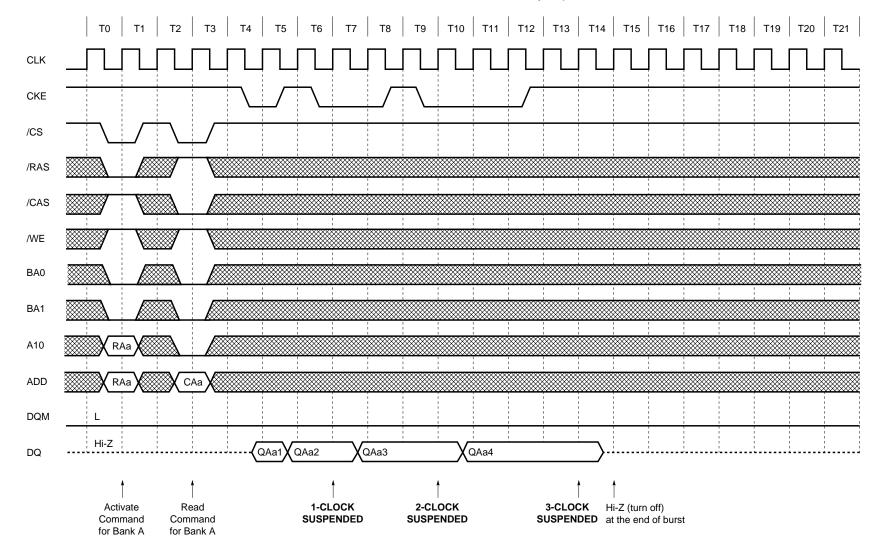




Only /CS signal needs to be issued at minimum rate

Data Sheet E0031N30

μPD45128441, 45128841, 451<u>2</u>8163

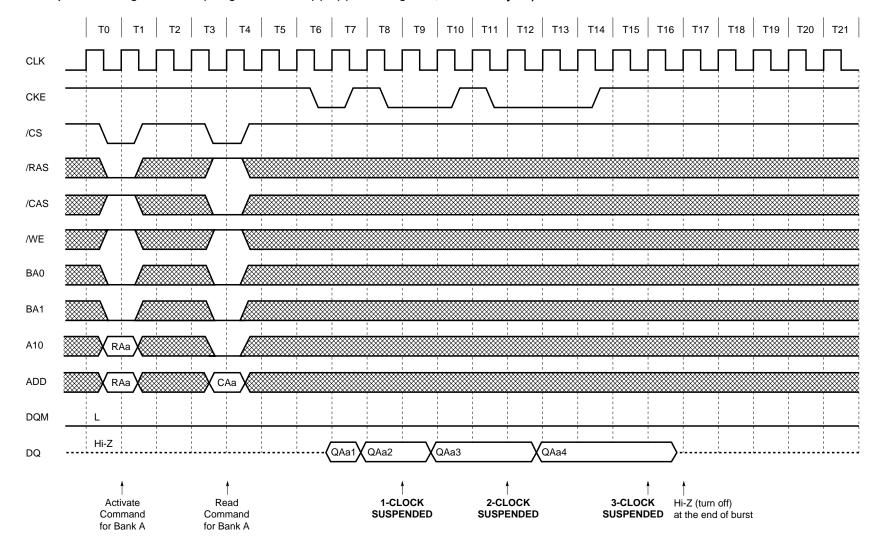


# a 13.7 Clock Suspension during Burst Read (using CKE Function) (1/2) (Burst Length = 4, /CAS Latency = 2)

Data Sheet E0031N30

ELPIDA

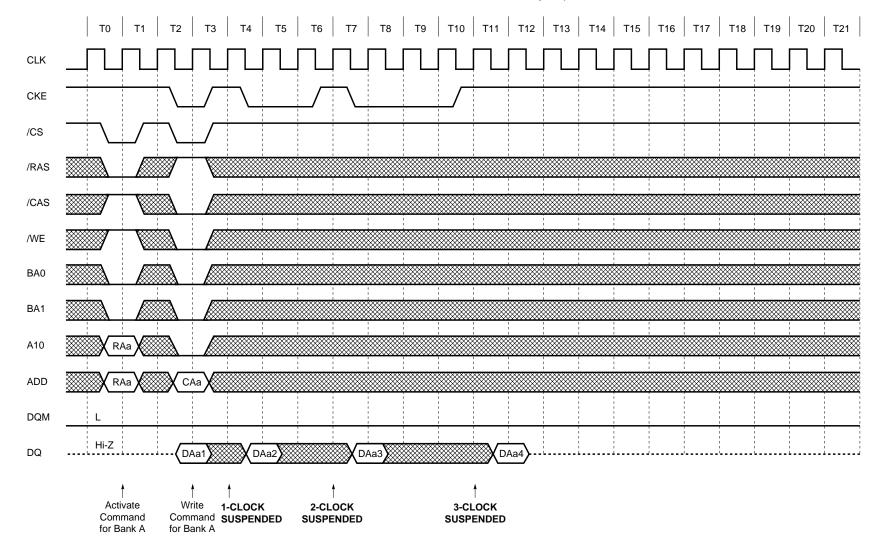
μPD45128441, 45128841, 45128163



#### Clock Suspension during Burst Read (using CKE Function) (2/2) (Burst Length = 4, /CAS Latency = 3)

µPD45128441, 45128841, 45128163

ELPIDA

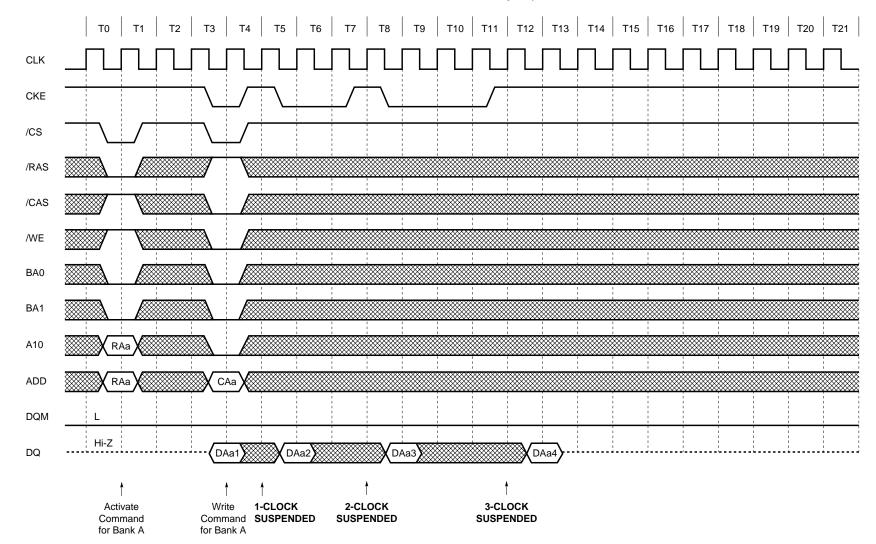


## 13.8 Clock Suspension during Burst Write (using CKE Function) (1/2) (Burst Length = 4, /CAS Latency = 2)

Data Sheet E0031N30

µPD45128441, 45128841, 45128163

ELPIDA

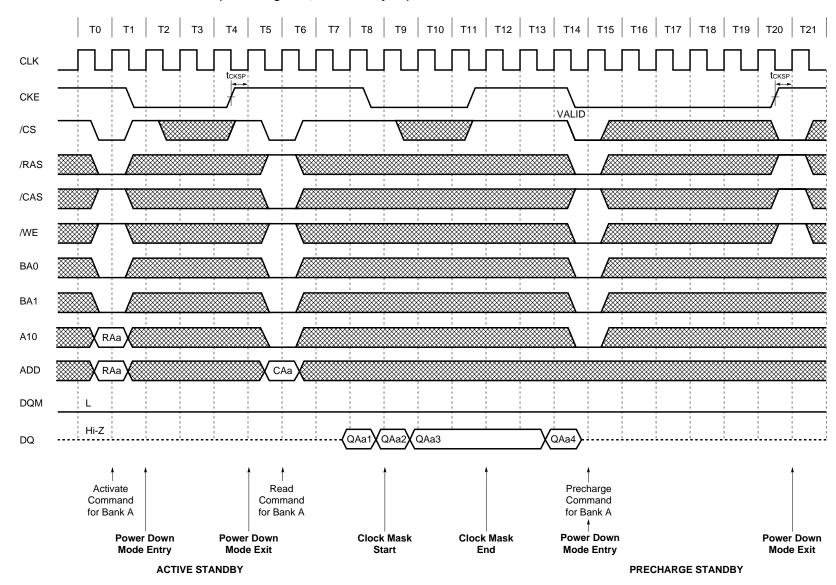


#### Clock Suspension during Burst Write (using CKE Function) (2/2) (Burst Length = 4, /CAS Latency = 3)

Data Sheet E0031N30

μPD45128441, 45128841, 45128163

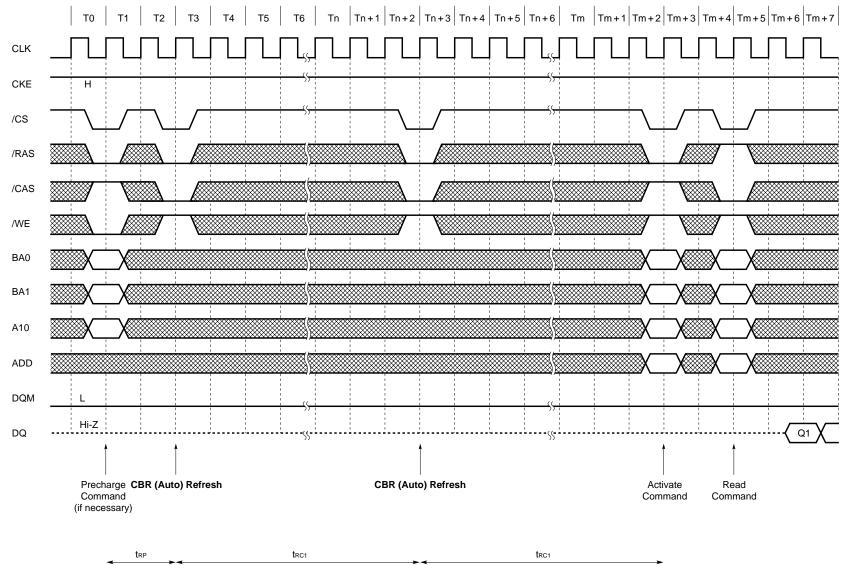
ELPIDA

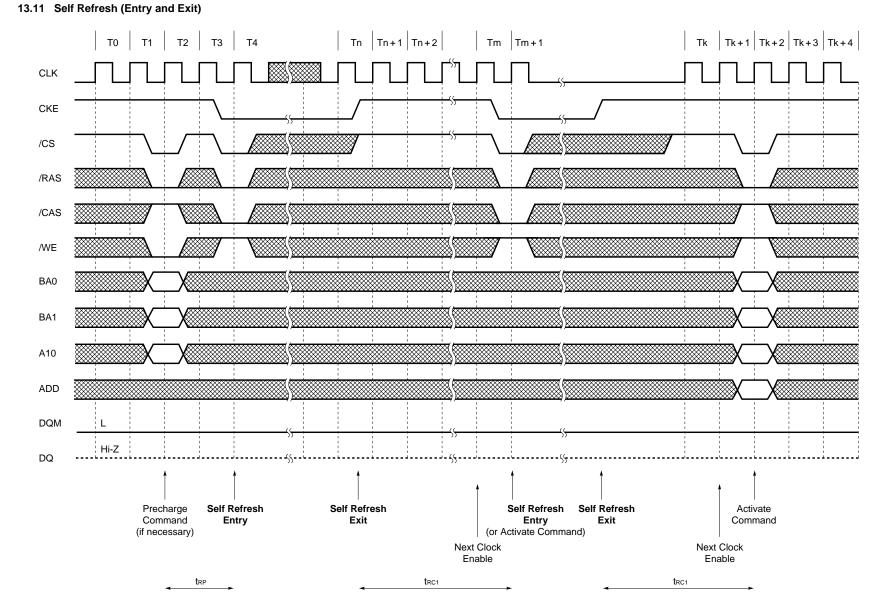


ELPIDA

ELPIDA

#### 13.10 CBR (Auto) Refresh

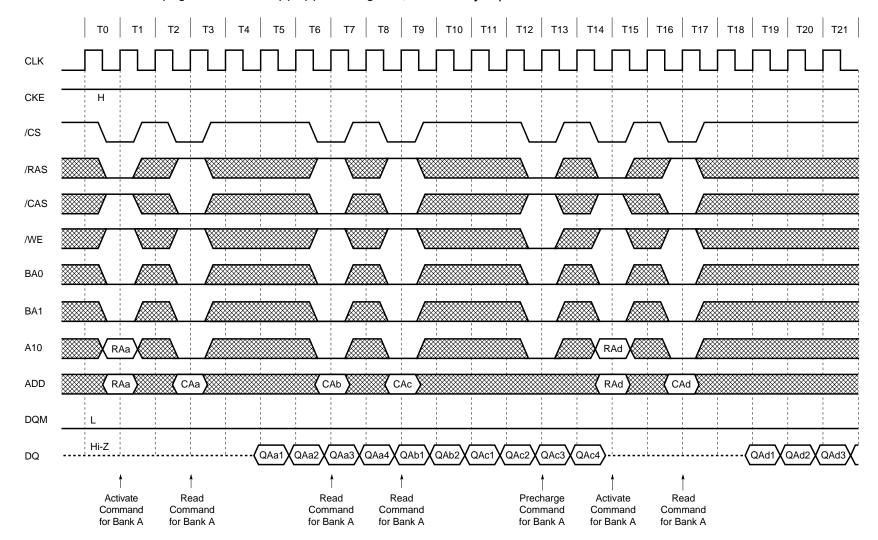




Data Sheet E0031N30

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μPD45128441, 45128841, 45128163

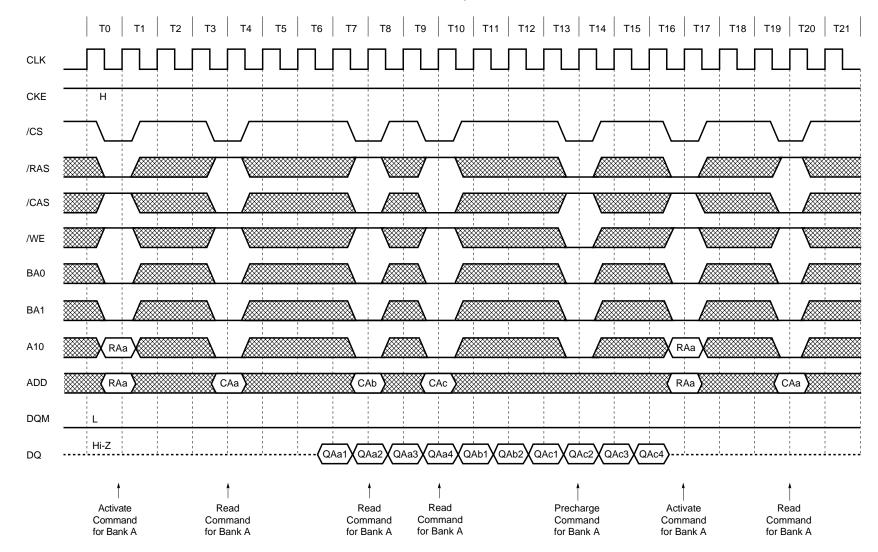


#### 13.12 Random Column Read (Page with Same Bank) (1/2) (Burst Length = 4, /CAS Latency = 2)

Data Sheet E0031N30

µPD45128441, 45128841, 45128163

ELPIDA



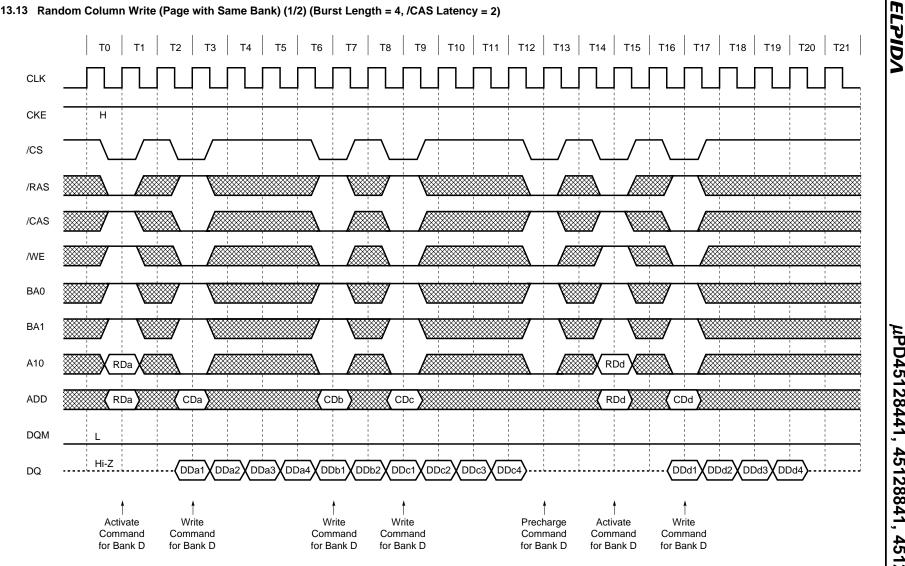
## Random Column Read (Page with Same Bank) (2/2) (Burst Length = 4, /CAS Latency = 3)

Data Sheet E0031N30

μPD45

ELPIDA

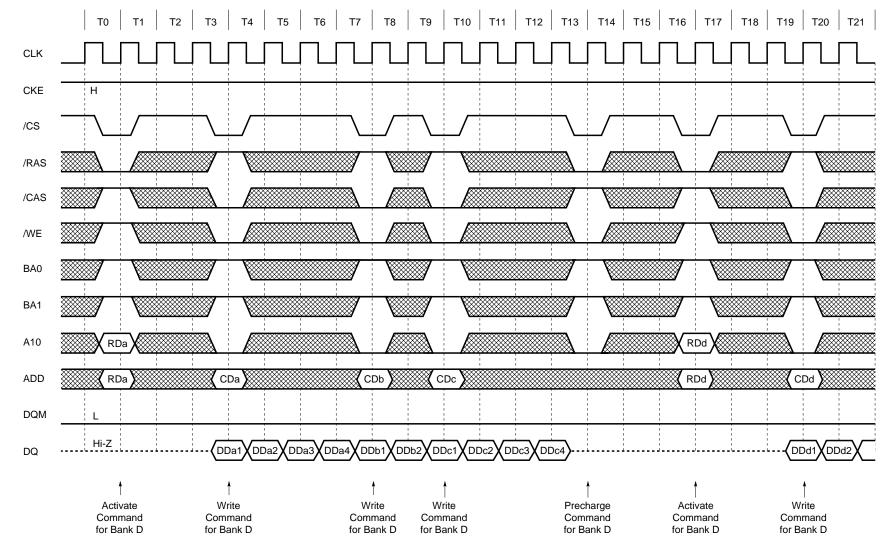
μPD45128441, 45128841, 45128163



#### 13.13 Random Column Write (Page with Same Bank) (1/2) (Burst Length = 4, /CAS Latency = 2)

Data Sheet E0031N30

<sup>µ</sup>PD45128441, 45128841, 45128163

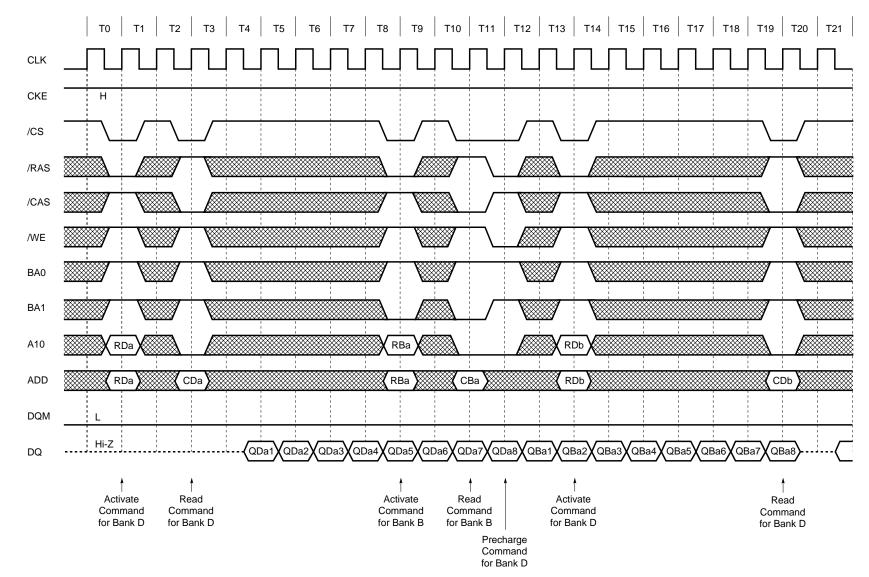


## 8 Random Column Write (Page with Same Bank) (2/2) (Burst Length = 4, /CAS Latency = 3)

Data Sheet E0031N30

µPD45128441, 45128841, 45128163

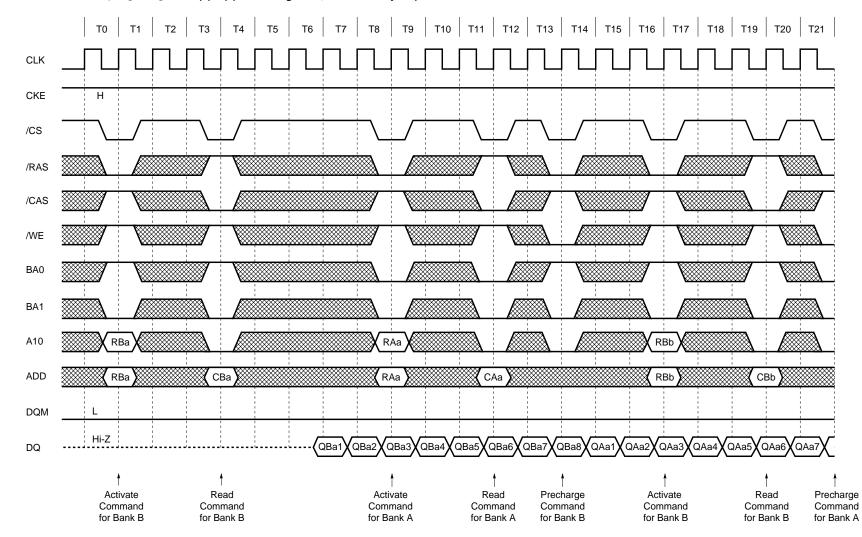
ELPIDA



#### 13.14 Random Row Read (Ping-Pong Banks) (1/2) (Burst Length = 8, /CAS Latency = 2)

Data Sheet E0031N30

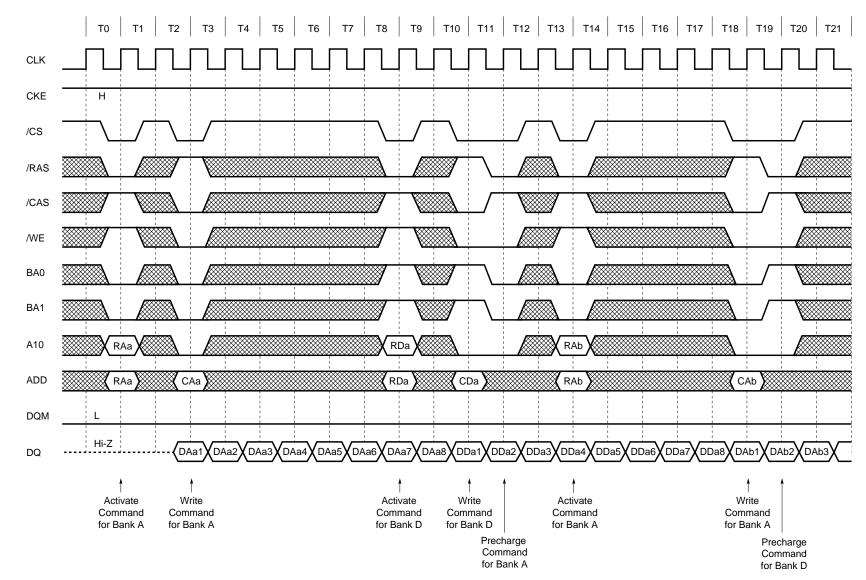
μPD45128441, 45128841, 45128163



# 8 Random Row Read (Ping-Pong Banks) (2/2) (Burst Length = 8, /CAS Latency = 3)

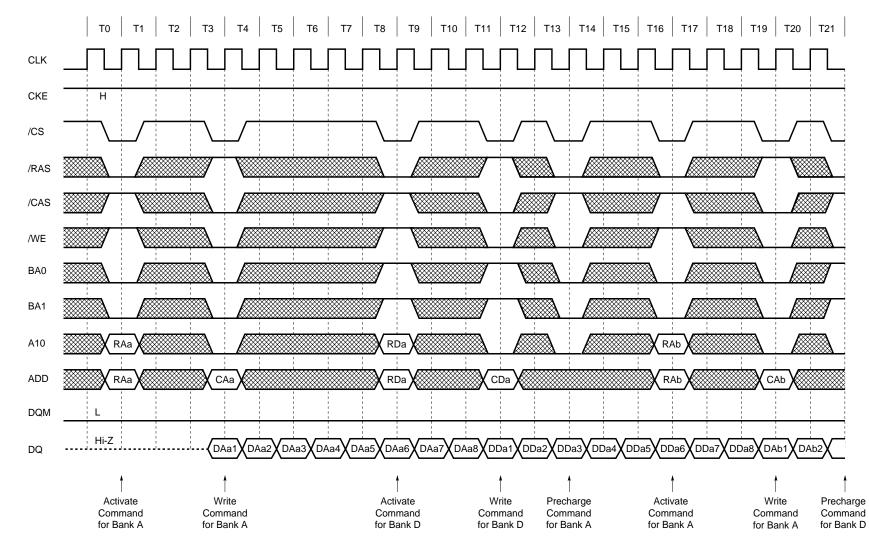
ELPIDA

μPD45128441, 45128841, 45128163



### 13.15 Random Row Write (Ping-Pong Banks) (1/2) (Burst Length = 8, /CAS Latency = 2)

<sup>µ</sup>PD45128441, 45128841, 45128163

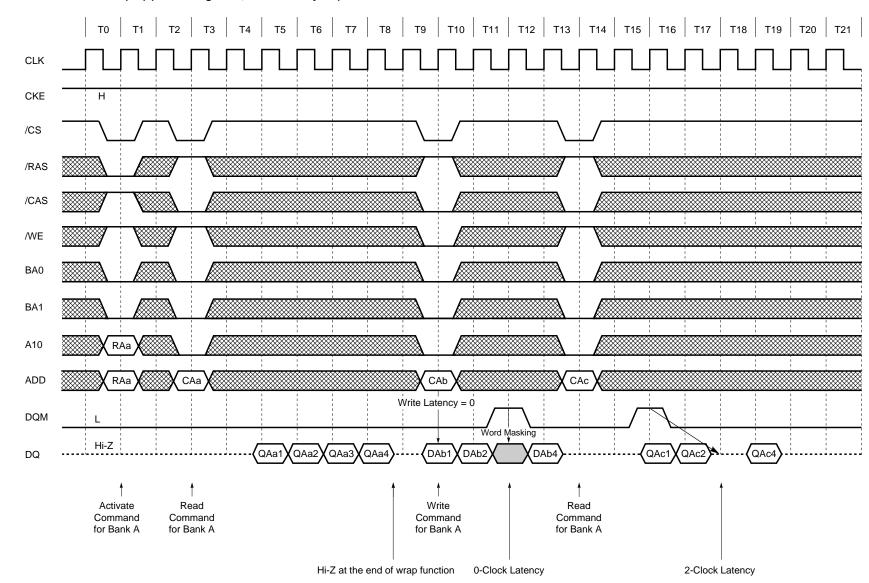


#### 60 Random Row Write (Ping-Pong Banks) (2/2) (Burst Length = 8, /CAS Latency = 3)

Data Sheet E0031N30

ELPIDA

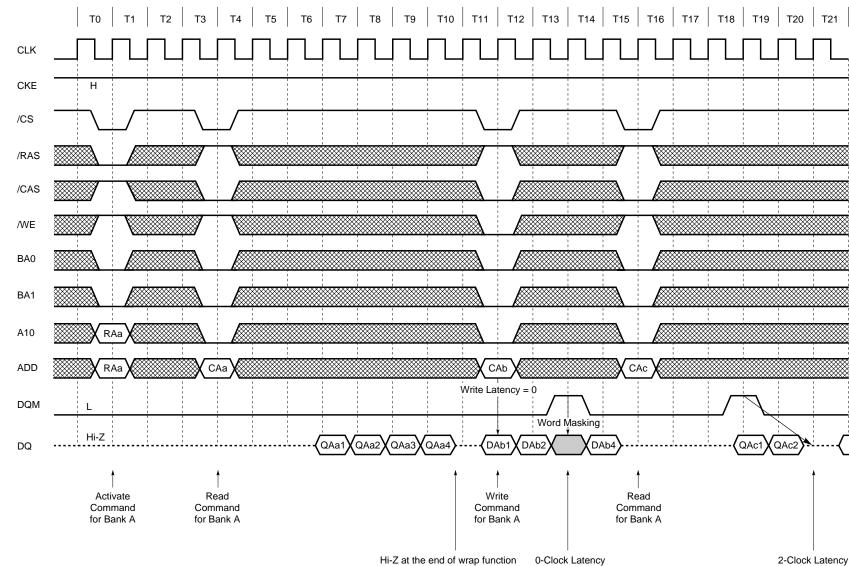
<sup>µ</sup>PD45128441, 45128841, 45128163



## 13.16 Read and Write (1/2) (Burst Length = 4, /CAS Latency = 2)

Data Sheet E0031N30

µPD45128441, 45128841, 45128163

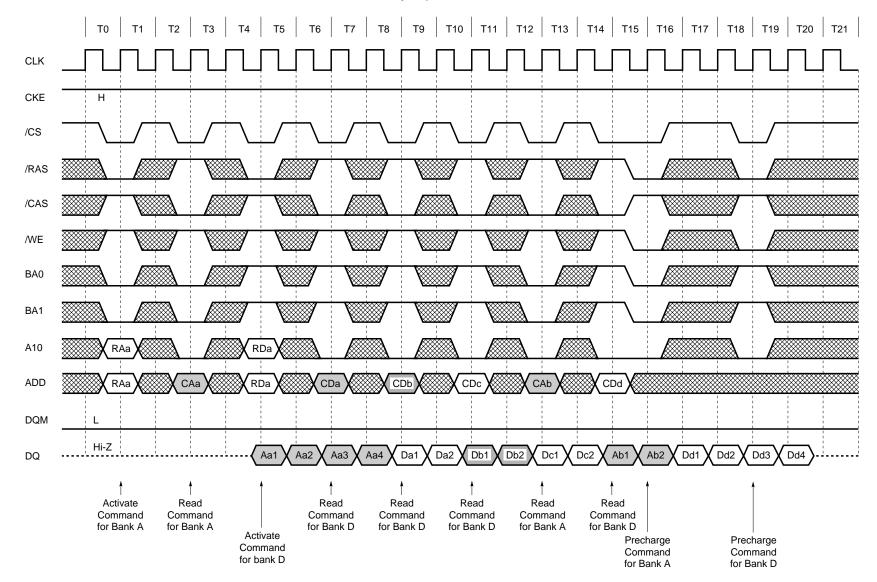


#### 62 Read and Write (2/2) (Burst Length = 4, /CAS Latency = 3)

Data Sheet E0031N30

<sup>µ</sup>PD45128441, 45128841, 45128163

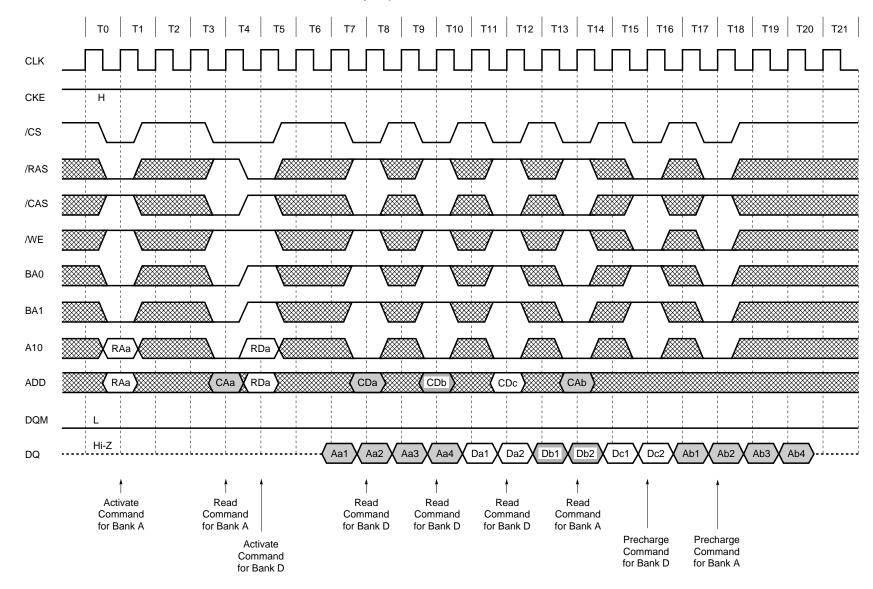
2-Clock Latency



#### 13.17 Interleaved Column Read Cycle (1/2) (Burst Length = 4, /CAS Latency = 2)

µPD45128441, 45128841, 45128163

ELPIDA

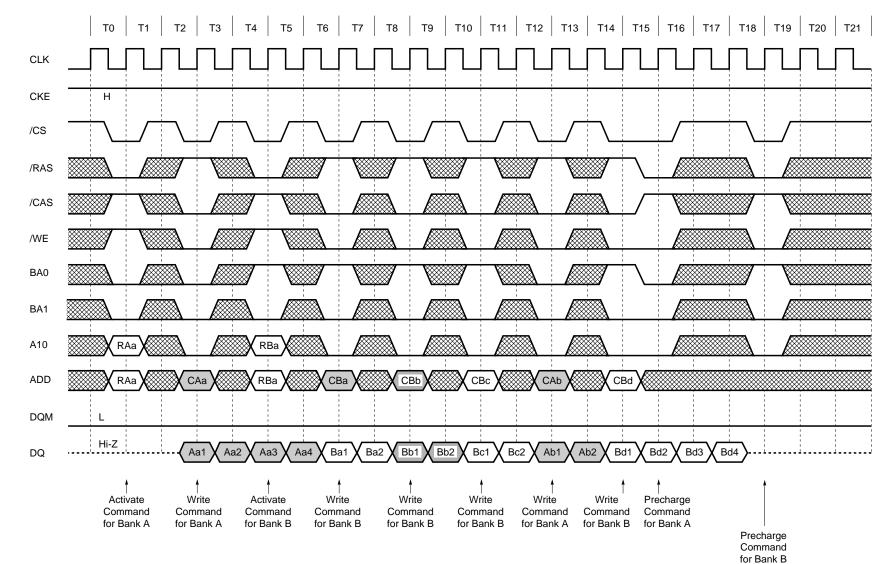


## <sup>2</sup> Interleaved Column Read Cycle (2/2) (Burst Length = 4, /CAS Latency = 3)

Data Sheet E0031N30

µPD45128441, 45128841, 45128163

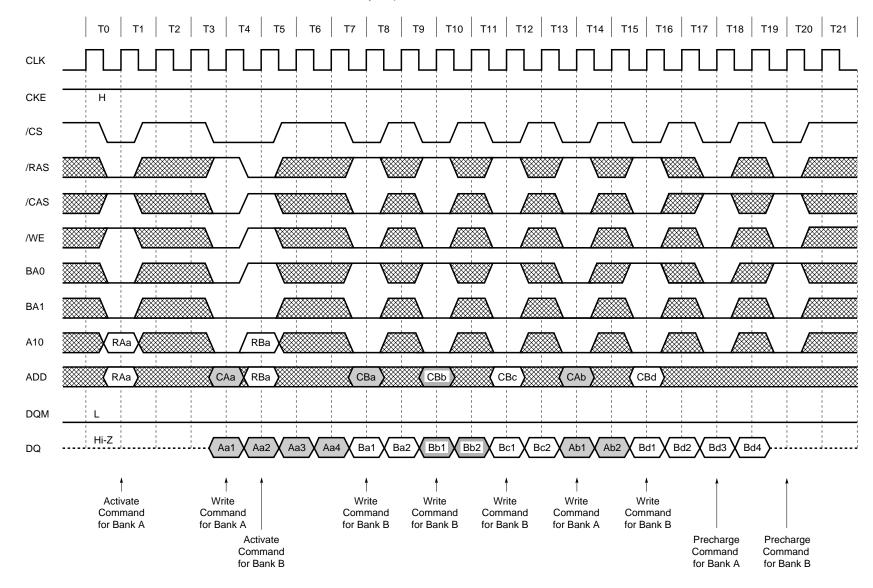
ELPIDA



### 13.18 Interleaved Column Write Cycle (1/2) (Burst Length = 4, /CAS Latency = 2)

μPD45128441, 45128841, 45128163

ELPIDA

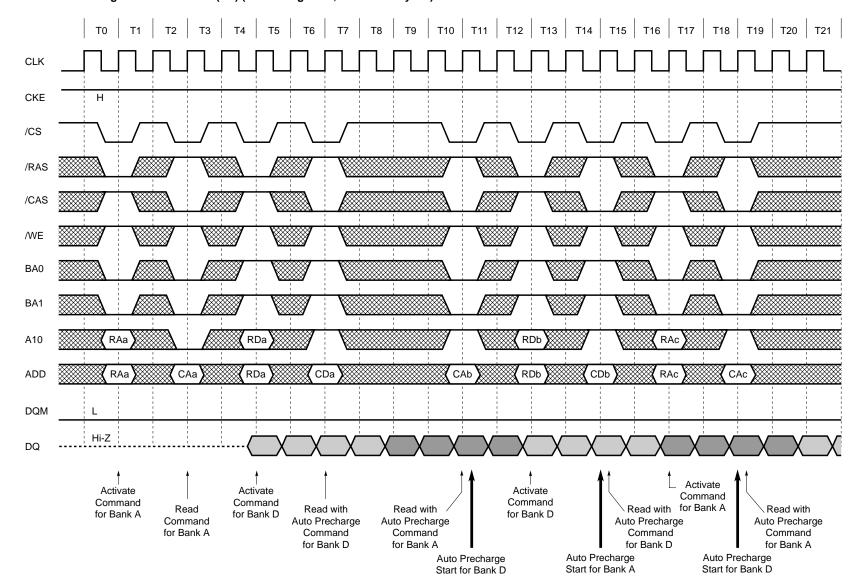


## 8 Interleaved Column Write Cycle (2/2) (Burst Length = 4, /CAS Latency = 3)

Data Sheet E0031N30

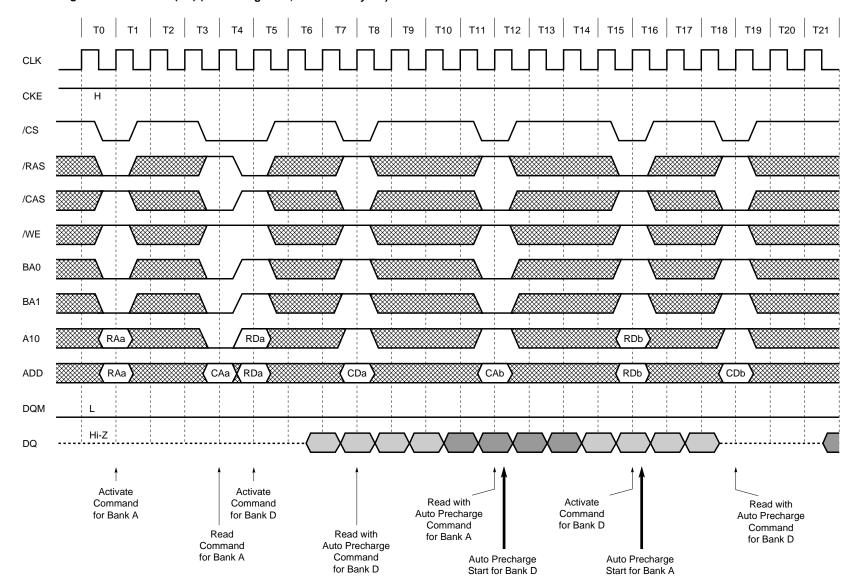
ELPIDA

μPD45128441, 45128841, 45128163



13.19 Auto Precharge after Read Burst (1/2) (Burst Length = 4, /CAS Latency = 2)

ELPIDA

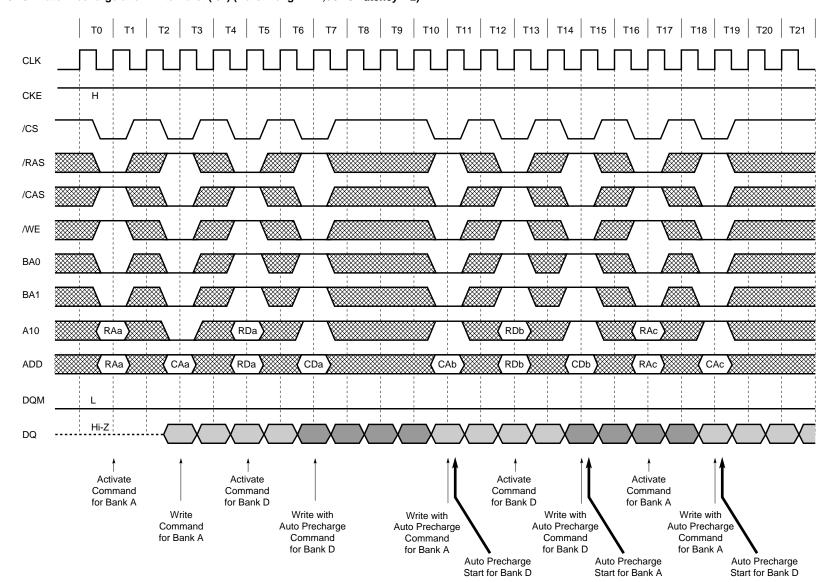


#### 89 Auto Precharge after Read Burst (2/2) (Burst Length = 4, /CAS Latency = 3)

Data Sheet E0031N30

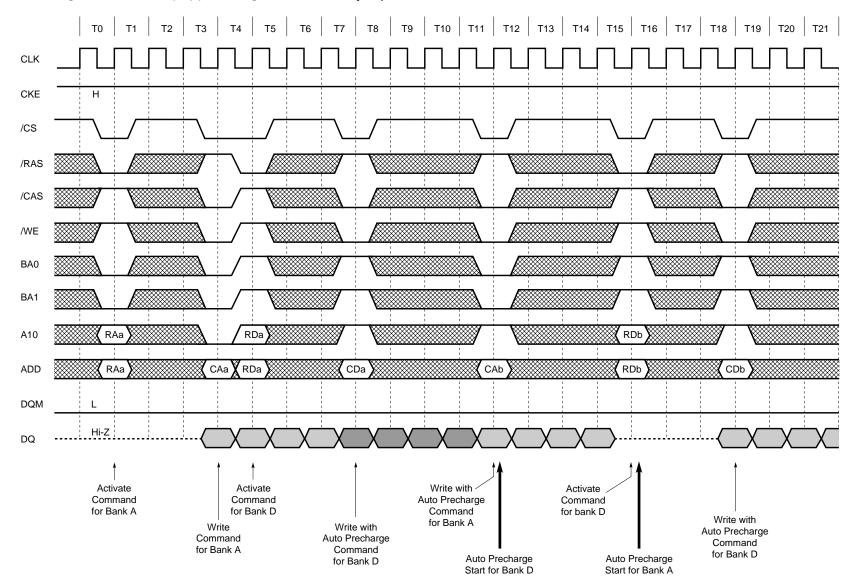
ELPIDA

<sup>µ</sup>PD45128441, 45128841, 45128163



13.20 Auto Precharge after Write Burst (1/2) (Burst Length = 4, /CAS Latency = 2)

ELPIDA

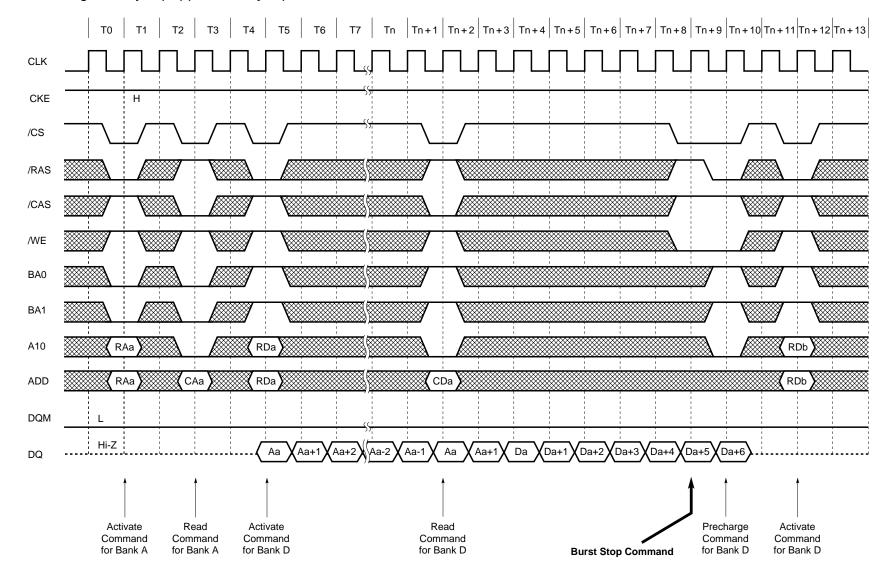


## Auto Precharge after Write Burst (2/2) (Burst Length = 4, /CAS Latency = 3)

Data Sheet E0031N30

ELPIDA

μPD45128441, 45128841, 45128163

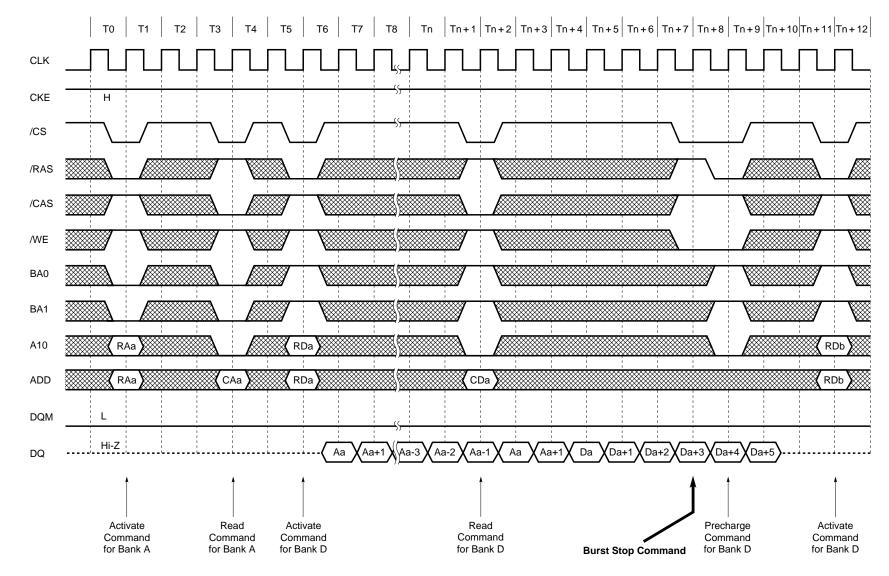


#### 13.21 Full Page Read Cycle (1/2) (/CAS Latency = 2)

Data Sheet E0031N30

μPD45128441, 45128841, 45128163

ELPIDA

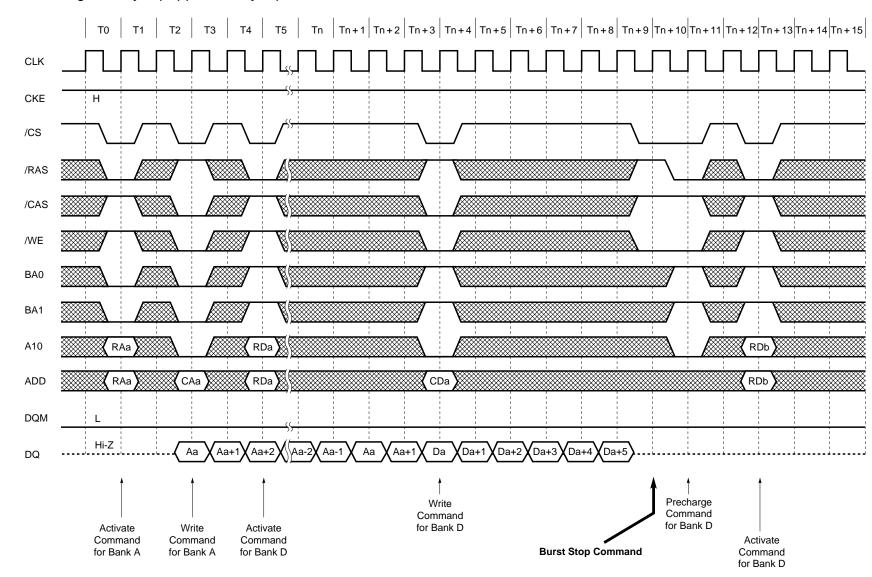


# S Full Page Read Cycle (2/2) (/CAS latency = 3)

Data Sheet E0031N30

ELPIDA

<sup>µ</sup>PD45128441, 45128841, 45128163

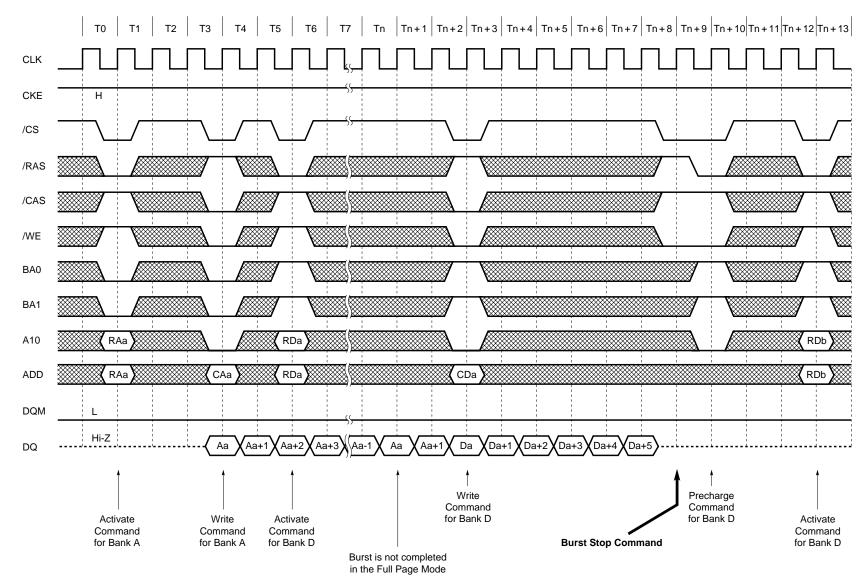


## 13.22 Full Page Write Cycle (1/2) (/CAS latency = 2)

Data Sheet E0031N30

μPD451284

ELPIDA

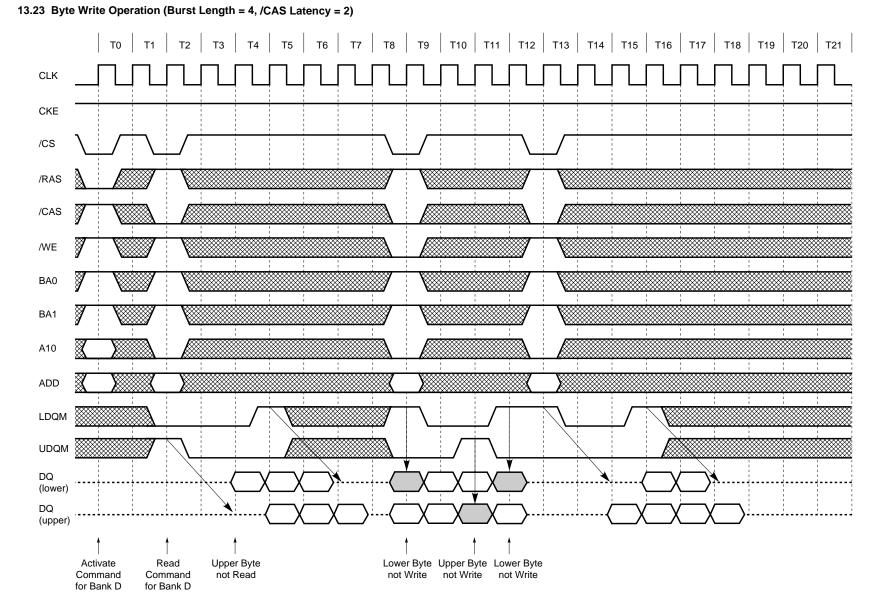


# Full Page Write Cycle (2/2) (/CAS Latency = 3)

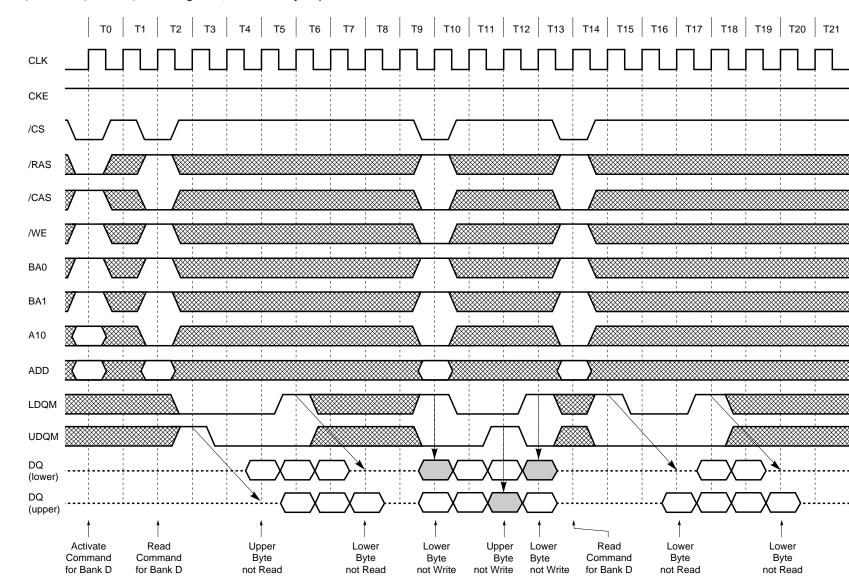
Data Sheet E0031N30

ELPIDA

μPD45128441, 45128841, 45128163



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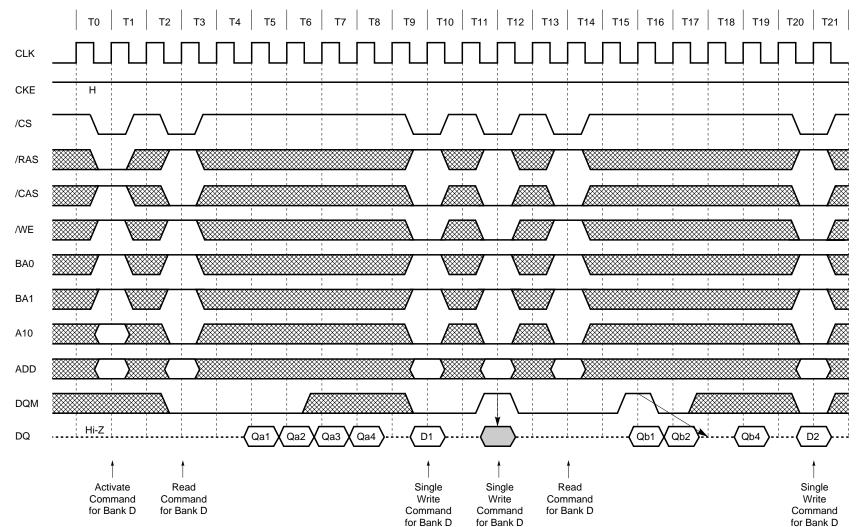


#### 76 Byte Write Operation (Burst Length = 4, /CAS Latency = 3)

Data Sheet E0031N30

# ELPIDA

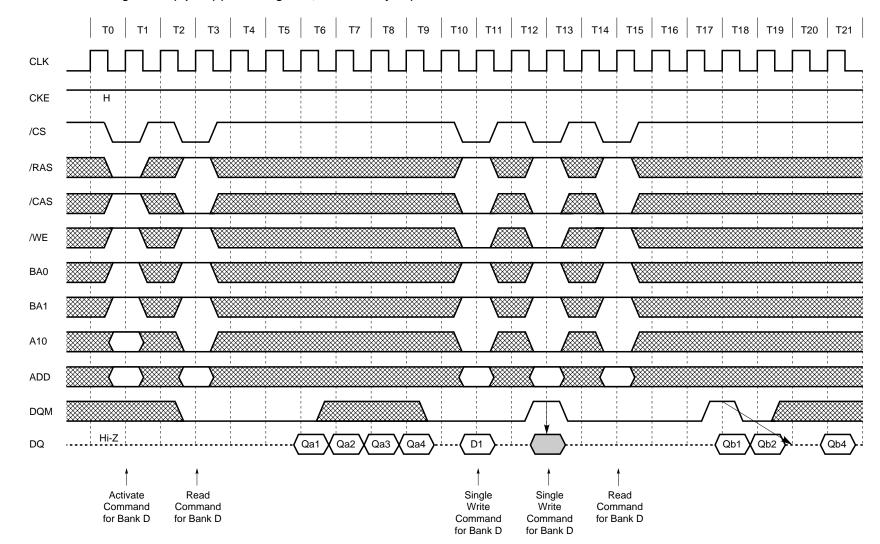
<sup>µ</sup>PD45128441, 45128841, 45128163



## 13.24 Burst Read and Single Write (Option) (Burst Length = 4, /CAS Latency = 2)

μPD45128441, 45128841, 45128163

77

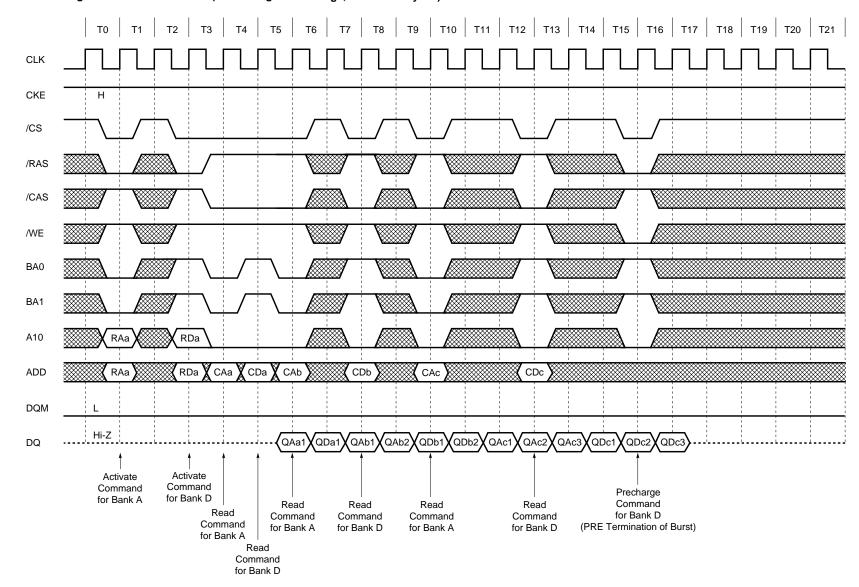


# Burst Read and Single Write (Option) (Burst Length = 4, /CAS Latency = 3)

Data Sheet E0031N30

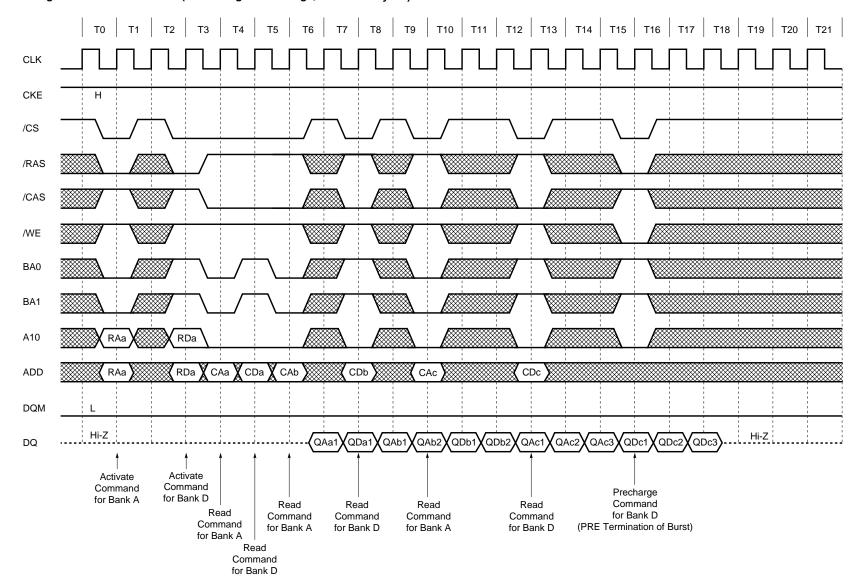
µPD45128441, 45128841, 45128163

ELPIDA



13.25 Full Page Random Column Read (Burst Length = Full Page, /CAS Latency = 2)

ELPIDA

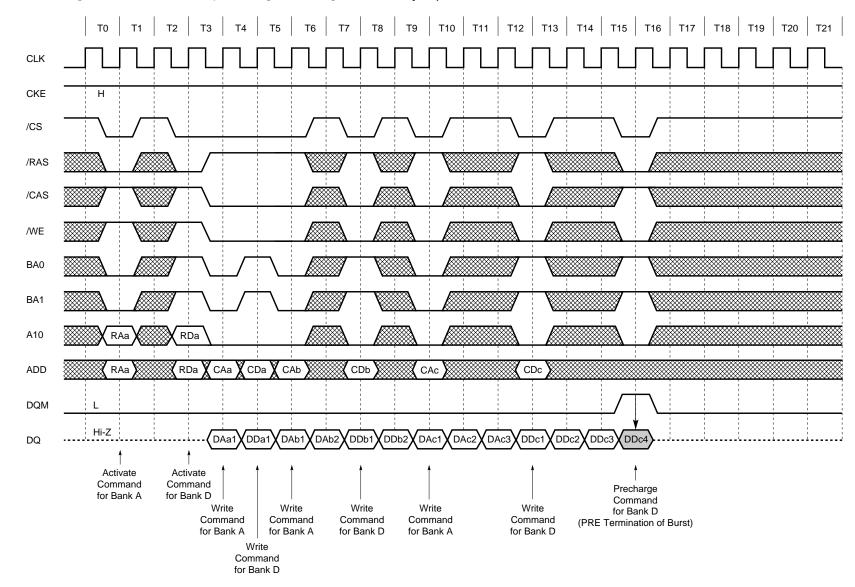


# 8 Full Page Random Column Read (Burst Length = Full Page, /CAS Latency = 3)

Data Sheet E0031N30

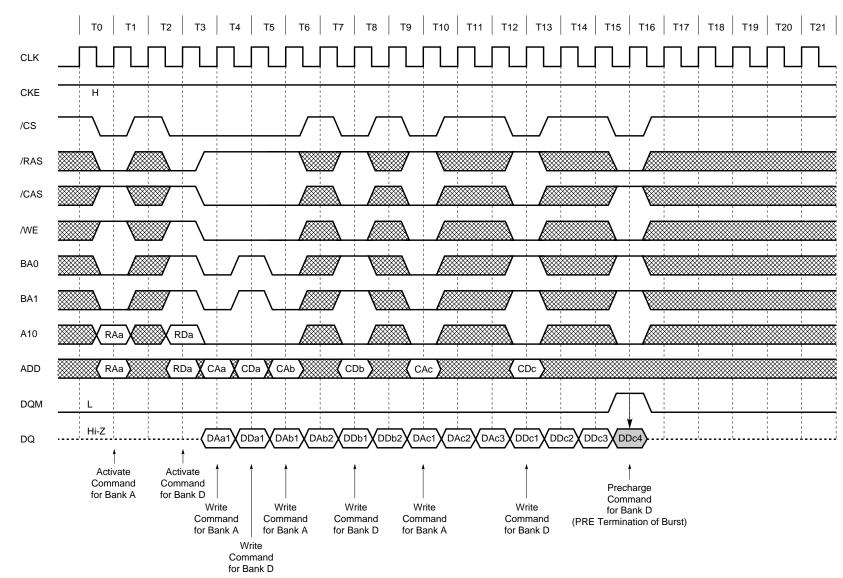
ELPIDA

μPD45128441, 45128841, 45128163

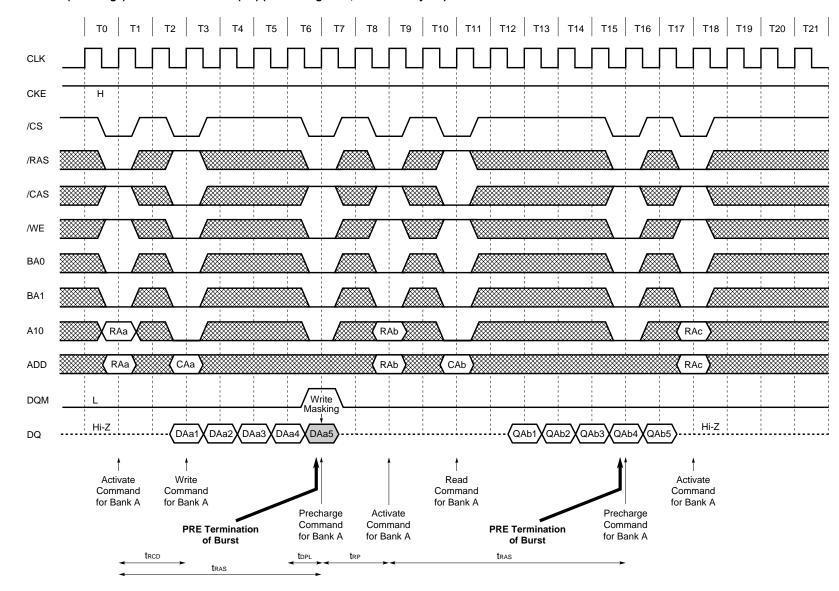


13.26 Full Page Random Column Write (Burst Length = Full Page, /CAS Latency = 2)

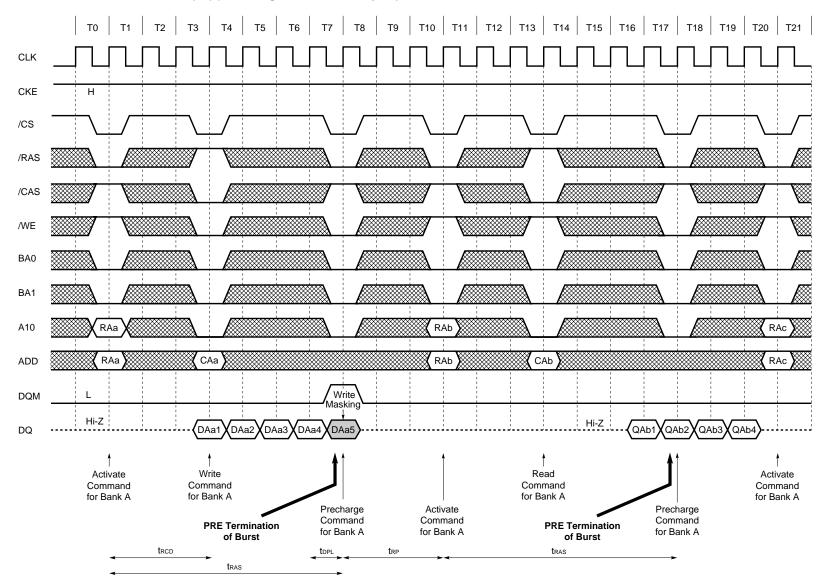
<u>%</u>



82



83

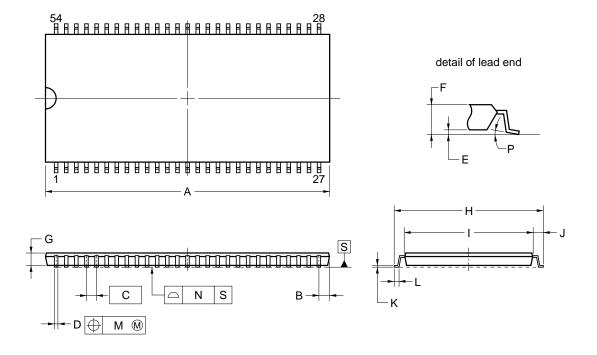


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ELPIDA

# 14. Package Drawing

# 54-PIN PLASTIC TSOP (II) (10.16 mm (400))



#### NOTES

- 1. Each lead centerline is located within 0.13 mm of its true position (T.P.) at maximum material condition.
- Dimension "A" does not include mold fiash, protrusions or gate burrs. Mold flash, protrusions or gate burrs shall not exceed 0.15 mm per side.

| ITEM | MILLIMETERS                   |
|------|-------------------------------|
| A    | 22.22±0.05                    |
| В    | 0.91 MAX.                     |
| С    | 0.80 (T.P.)                   |
| D    | $0.32\substack{+0.08\\-0.07}$ |
| E    | 0.10±0.05                     |
| F    | 1.1±0.1                       |
| G    | 1.00                          |
| Н    | 11.76±0.20                    |
| I    | 10.16±0.10                    |
| J    | 0.80±0.20                     |
| к    | $0.145_{-0.015}^{+0.025}$     |
| L    | 0.50±0.10                     |
| М    | 0.13                          |
| N    | 0.10                          |
| Р    | 3° <sup>+7°</sup> 3°          |
|      | S54G5-80-9JF-2                |

# 15. Recommended Soldering Conditions

Please consult with our sales offices for soldering conditions of the  $\mu$ PD45128xxx.

## Type of Surface Mount Device

μPD45128xxxG5 : 54-pin Plastic TSOP (II) (10.16mm (400))

# 16. Revision History

| Edition /                  | Page                      |                           | Description               |  |
|----------------------------|---------------------------|---------------------------|---------------------------|--|
| Date                       | This edition              | Previous<br>edition       | Type of<br>revision       | Location   |
| NEC Corporat               | ion (M12650E              | E)                        |                           |  |
| 9th edition /<br>Mar. 1999 | p.15                      | p.15                      | Modification,<br>Addition | CKE Truth Table - Power down                                       |
|                            | p.19                      | p.19                      | Modification,<br>Addition | Command Truth Table for CKE - Power down                           |
|                            | p.35                      | p.35                      | Modification              | Icc1 (spec), Icc2NS (spec), Icc3N (spec), Icc4 (spec), Icc5 (spec) |
|                            | p.37                      | p.37                      | Modification              | Output load  |
|                            | p.50                      | p.50                      | Modification              | Timing Chart (Power Down Mode and Clock Mask)                      |
|                            | p.77                      | p.77                      | Modification              | Timing Chart (Full Page Random Column Read)                        |
| 10th edition /             | Throughout                | Throughout                | Modification              | A13 → BA0, A12 → BA1   |
| Jan. 2000                  | p.2, 3                    | p.2, 3                    | Addition                  | -A75   |
|                            |                           |                           | Deletion                  | -AxxL (Low power)  |
|                            | p.34                      | p.34                      | Addition                  | Pin Capacitance (MAX.)   |
|                            | p.35                      | p.35                      | Addition                  | -A75 specs   |
|                            |                           |                           | Modification              | lccs   |
|                            |                           |                           | Deletion                  | Icce -AxxL (Low power)   |
|                            | p.36                      | p.36                      | Modification              | AC Characteristics Test Conditions                                 |
|                            | p.37, 38,<br>42           | p.37, 38,<br>42           | Addition                  | -A75 specs   |
|                            | p.76, 78,<br>80, 82       | -                         | Addition                  | Timing chart (/CAS latency = 3)                                    |
|                            | p.85                      | p.81                      | Modification              | Package Drawing  |
| 11th edition /             | p.38                      | p.38                      | Modification              | t <sub>RC1</sub> spec (-A10)                                       |
| Apr. 2000                  |                           |                           |                           |  |
| Elpida Memor               | y, Inc. (E0031            | N)                        |                           |  |
| 1st edition /<br>Jan. 2001 | -                         | -                         | -                         | Republished by Elpida Memory, Inc.                                 |
| Ver. 2.0 /<br>June 2001    | p.2, 3                    | p.2, 3                    | Addition                  | -AxxL (Low power)  |
|                            | p.2, 3, 35,<br>37, 38, 42 | p.2, 3, 35,<br>37, 38, 42 | Deletion                  | -10B specs   |
|                            | p.35                      | p.35                      | Addition                  | Icce -AxxL (Low power)   |
| Ver. 3.0 /                 | p.2, 3                    | p.2, 3                    | Addition                  | -A75A and -A75AL (Low power)                                       |
| August 2001                | p.35, 37,<br>38           | p.35, 37,<br>38           | Addition                  | -A75A specs  |

[MEMO]

[MEMO]

[MEMO]

## NOTES FOR CMOS DEVICES -

## **①** PRECAUTION AGAINST ESD FOR MOS DEVICES

Exposing the MOS devices to a strong electric field can cause destruction of the gate oxide and ultimately degrade the MOS devices operation. Steps must be taken to stop generation of static electricity as much as possible, and quickly dissipate it, when once it has occurred. Environmental control must be adequate. When it is dry, humidifier should be used. It is recommended to avoid using insulators that easily build static electricity. MOS devices must be stored and transported in an anti-static container, static shielding bag or conductive material. All test and measurement tools including work bench and floor should be grounded. The operator should be grounded using wrist strap. MOS devices must not be touched with bare hands. Similar precautions need to be taken for PW boards with semiconductor MOS devices on it.

## **②** HANDLING OF UNUSED INPUT PINS FOR CMOS DEVICES

No connection for CMOS devices input pins can be a cause of malfunction. If no connection is provided to the input pins, it is possible that an internal input level may be generated due to noise, etc., hence causing malfunction. CMOS devices behave differently than Bipolar or NMOS devices. Input levels of CMOS devices must be fixed high or low by using a pull-up or pull-down circuitry. Each unused pin should be connected to VDD or GND with a resistor, if it is considered to have a possibility of being an output pin. The unused pins must be handled in accordance with the related specifications.

## **③** STATUS BEFORE INITIALIZATION OF MOS DEVICES

Power-on does not necessarily define initial status of MOS devices. Production process of MOS does not define the initial operation status of the device. Immediately after the power source is turned ON, the MOS devices with reset function have not yet been initialized. Hence, power-on does not guarantee output pin levels, I/O settings or contents of registers. MOS devices are not initialized until the reset signal is received. Reset operation must be executed immediately after power-on for MOS devices having reset function.

CME0107

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